

# BMP388

## Digital pressure sensor



### **BMP388 – Datasheet**

|                             |                     |
|-----------------------------|---------------------|
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|       |                                                                                                                                                                                              |
|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
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## BMP388

### Digital pressure sensor

The BMP388 is a digital sensor with pressure and temperature measurement based on proven sensing principles. The sensor module is housed in an extremely compact 10-pin metal-lid LGA package with a footprint of only  $2.0 \times 2.0 \text{ mm}^2$  and max 0.8 mm package height. Its small dimensions and its low power consumption of  $3.4 \mu\text{A}$  @1Hz allow the implementation in battery driven devices such as mobile phones, GPS modules or watches.

#### Typical applications

- Vertical velocity indication (e.g. rise/sink speed)
- Internet of things
- Enhancement of GPS navigation  
(e.g. time-to-first-fix improvement, dead-reckoning, slope detection)
- Indoor navigation & localization (floor detection, elevator detection)
- Outdoor navigation, leisure and sports applications
- Weather forecast
- Health care applications (e.g. spirometry)
- Fitness applications like enhancement of calorie detection
- AR & VR applications
- Context awareness

#### Target Devices

- Flying toys
- Drones
- Handsets such as mobile phones, tablet PCs, GPS devices
- Navigation systems
- Portable health care devices
- Home weather stations
- Watches
- White goods

## Key features

Table 1: Key Features of BMP388

|                                                          |                                                                                                                         |
|----------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------|
| <b>Package</b>                                           | 2.0 mm x 2.0 mm x 0.75 mm metal lid LGA                                                                                 |
| <b>Digital interface</b>                                 | I <sup>2</sup> C (up to 3.4 MHz) and SPI (3 and 4 wire, up to 10 MHz)                                                   |
| <b>Supply voltage</b>                                    | V <sub>DD</sub> main supply voltage range: 1.65 V to 3.6 V<br>V <sub>DDIO</sub> interface voltage range: 1.2 V to 3.6 V |
| <b>Relative accuracy</b>                                 | typ. ± 8 Pa, equiv. to ± 0.66 m<br>(900 ... 1100 hPa, 25 ... 40 °C)                                                     |
| <b>Absolute accuracy</b>                                 | typ. ± 50 Pa<br>(300 ... 1100 hPa, -20 ... +65 °C)                                                                      |
| <b>Temperature coefficient offset</b>                    | typ. ± 0.75 Pa/K<br>(0 ... 55°C @ 700 -1100 hPa)                                                                        |
| <b>Current consumption</b>                               | 3.4 µA at 1 Hz pressure and temperature<br>2.0 µA in sleep mode                                                         |
| <b>Operating range</b>                                   | -40 – +85 °C, 300–1250 hPa                                                                                              |
| <b>The product is RoHS compliant, halogen-free, MSL1</b> |                                                                                                                         |

BMP388 enables accurate altitude tracking and is specifically suited for drone applications. The best-in-class TCO between -20-65°C for accurate altitude measurement over a wide temperature range of the BMP388 greatly enhance the drone flying experience by making accurate steering easier. It is compatible for use with other Bosch sensors, including the new BMI088 for better performance, robustness and stability. The new BMP388 sensor offers outstanding design flexibility, providing a single package solution that can also be easily integrated into other existing and upcoming devices such as smart homes, industrial products and wearables.

The sensor is more accurate than its predecessor BMP280, covering a wide measurement range from 300 hPa to 1250 hPa. This new barometric pressure sensor exhibits an attractive price-performance ratio coupled with low power consumption. It is available in a compact 10-in 2.0 x 2.0 x 0.75 mm<sup>3</sup> LGA package with metal lid

Due to the built-in hardware synchronization of the pressure sensor data and its ability to synchronize data from external devices such as acceleration sensors, the BMP388 is ideally suited for fitness and navigation applications which require highly accurate, low power and low latency sensor data fusion.

The new interrupt functionality provides simple access to data and storage. Examples of interrupts than can be used in a power efficient manner without using software algorithms include: Data ready interrupt, watermark interrupt (on byte level) or FIFO full interrupt.

BMP388 also includes a new FIFO functionality. This greatly improves ease of use while helping to reduce power consumption of the overall device system during full operation. The integrated 512 byte FIFO buffer supports low power applications and prevents data loss in non-real-time systems.

# Table of contents

|                                                            |           |
|------------------------------------------------------------|-----------|
| <b>1. Specification.....</b>                               | <b>6</b>  |
| <b>2. Absolute maximum ratings.....</b>                    | <b>8</b>  |
| <b>3. Functional description .....</b>                     | <b>8</b>  |
| 3.1. Block diagram .....                                   | 9         |
| 3.2. Power management .....                                | 10        |
| 3.3. Power modes .....                                     | 10        |
| 3.4. Measurement flow .....                                | 12        |
| 3.5. Filter selection.....                                 | 16        |
| 3.6. FIFO Description.....                                 | 17        |
| 3.7. Interrupts.....                                       | 21        |
| 3.8. Current consumption .....                             | 25        |
| 3.9. Measurement timings .....                             | 25        |
| 3.10. Data readout from data registers .....               | 26        |
| 3.11. Output compensation .....                            | 27        |
| <b>4. Global memory map and register description .....</b> | <b>28</b> |
| 4.1. General remarks .....                                 | 28        |
| 4.2. Datasheet Memory Map .....                            | 28        |
| 4.3. Register description .....                            | 30        |
| <b>5. Digital interfaces .....</b>                         | <b>39</b> |
| 5.1. Interface selection.....                              | 39        |
| 5.2. I <sup>2</sup> C Interface .....                      | 39        |
| 5.3. SPI interface .....                                   | 41        |
| 5.4. Interface parameter specification .....               | 42        |
| <b>6. Pin-out and connection diagram .....</b>             | <b>45</b> |
| 6.1. Pin-out .....                                         | 45        |
| 6.2. Connection diagram 3/4-wire SPI.....                  | 46        |
| 6.3. Connection diagram I <sup>2</sup> C.....              | 47        |
| <b>7. Package, reel and environment.....</b>               | <b>48</b> |
| 7.1. Outline dimensions .....                              | 48        |
| 7.2. Landing pattern.....                                  | 48        |

- 7.3. Marking .....49
- 7.4. Soldering guidelines .....50
- 7.5. Tape and reel specification .....51
- 7.6. Mounting and assembly recommendations .....51
- 7.7. Environmental safety .....52
  
- 8. Legal disclaimer .....53**
  - 8.1. Engineering samples .....53
  - 8.2. Product use.....53
  - 8.3. Application examples and hints .....53
  
- 9. Appendix: Computation formulae reference implementation.....54**
  - 9.1. Calibration coefficient .....54
  - 9.2. Temperature compensation .....54
  - 9.3. Pressure compensation.....55
  
- 10. Document history and modification .....56**

## 1. Specification

If not stated otherwise,

- All values are valid over the full voltage range
- All minimum/maximum values are given for the full accuracy temperature range
- Minimum/maximum values of drifts, offsets and temperature coefficients are  $\pm 3\sigma$  values over lifetime
- Typical values of currents and state machine timings are determined at 25 °C
- Typical values of currents and state machine timings are determined at 25°C. minimum/maximum values of currents are determined at -40°C/85°C.
- Minimum/maximum values of state machine timings are determined using corner lots over 0...+65 °C temperature range.

Table 2: General electrical parameter specifications

| OPERATING CONDITIONS BMP388        |                                |                                               |      |                    |      |      |
|------------------------------------|--------------------------------|-----------------------------------------------|------|--------------------|------|------|
| Parameter                          | Symbol                         | Condition                                     | Min  | Typ                | Max  | Unit |
| Operating temperature range        | T <sub>A</sub>                 | operational                                   | -40  | 25                 | +85  | °C   |
|                                    |                                | full accuracy                                 | 0    |                    | +65  |      |
| Operating pressure range           | P                              | full accuracy                                 | 300  |                    | 1250 | hPa  |
| Sensor supply voltage              | V <sub>DD</sub>                | ripple max. 50mVpp                            | 1.65 | 1.8                | 3.6  | V    |
| Interface supply voltage           | V <sub>DDIO</sub>              |                                               | 1.2  | 1.8                | 3.6  | V    |
| Sleep current                      | I <sub>DD,sleep</sub>          | V <sub>DD</sub> = V <sub>DDIO</sub> 1.8-3.6 V |      | 2                  |      | μA   |
| Peak current                       | I <sub>peak</sub>              | during pressure measurement                   |      | 700                | 800  | μA   |
| Current at temperature measurement | I <sub>DDT</sub>               |                                               |      | 300                | 400  | μA   |
| Relative accuracy pressure         | A <sub>rel</sub>               | 900 ... 1100 hPa                              |      | ±0.08 <sup>1</sup> |      | hPa  |
|                                    |                                | 25 ... 40 °C                                  |      | ±66                |      | cm   |
| Offset temperature coefficient     | TCO                            | 700-1100 hPa                                  |      | ±0.75              |      | Pa/K |
|                                    |                                | 0 ... 55 °C                                   |      |                    |      |      |
| Absolute accuracy pressure         | A <sup>P</sup> <sub>full</sub> | 700-1100 hPa                                  |      | ±1.0               |      | Pa/K |
|                                    |                                | 0 ... 55 °C                                   |      |                    |      |      |
|                                    | A <sup>P</sup> <sub>ext</sub>  | 300. . 1100 hPa                               |      | ±0.50              |      | hPa  |
| Absolute accuracy pressure         | A <sup>P</sup> <sub>ext</sub>  | 900. . 1100 hPa                               |      | ±0.40              |      | hPa  |
|                                    |                                | 25 ... 40 °C                                  |      |                    |      |      |
| Absolute accuracy pressure         | A <sup>P</sup>                 | 1100 . . 1250 hPa                             | -1.5 | ±0.50              | 1.5  | hPa  |
|                                    |                                | 0 . . 65 °C                                   |      |                    |      |      |

<sup>1</sup> Mean value

|                                                                          |                      |                                                                                |  |        |                     |     |
|--------------------------------------------------------------------------|----------------------|--------------------------------------------------------------------------------|--|--------|---------------------|-----|
| Resolution of output data in highest resolution mode at lowest bandwidth | $R^P$                | Pressure                                                                       |  | 0.016  |                     | Pa  |
| Noise in pressure                                                        | $V_{p,full}$         | Full bandwidth, highest resolution<br>See chapter 3.4.4                        |  | 1.2    |                     | Pa  |
|                                                                          | $V_{p,filtered}$     | Lowest bandwidth, highest resolution<br>See chapter 3.4.4                      |  | 0.03   |                     | Pa  |
| Absolute accuracy temperature <sup>2</sup>                               | $A^T$                | @ 25 °C                                                                        |  | ±0.3   |                     | °C  |
|                                                                          |                      | 0 ... +65 °C                                                                   |  | ±0.50  |                     | °C  |
| Long term stability <sup>3</sup>                                         | $\Delta P_{stab}$    | 12 months                                                                      |  | ±0.33  |                     | hPa |
| Solder drifts                                                            |                      | Minimum solder height 50 $\mu m$                                               |  | < ±1.0 |                     | hPa |
| Start-up time                                                            | $t_{startup}$        | Time to first communication after both $V_{DD} > 1.58V$ and $V_{DDIO} > 0.65V$ |  |        | 2                   | ms  |
| Possible sampling rate                                                   | $f_{sample}$         | $osrs\_t = osrs\_p = 1$ ;<br>See chapter 3.9                                   |  |        | 200                 | Hz  |
| ODR accuracy                                                             | $\Delta t_{standby}$ | 25°C                                                                           |  | 2      | +/- 12 <sup>4</sup> | %   |

<sup>2</sup> Temperature measured by the internal temperature sensor. This temperature value depends on the PCB temperature, sensor element self-heating and ambient temperature and is typically above ambient temperature.

<sup>3</sup> Long term stability is specified in the full accuracy operating pressure range 0 ... 65°C

<sup>4</sup> From -40 to 85°C

## 2. Absolute maximum ratings

The absolute maximum ratings are provided in Table 3 .

Table 3: Absolute maximum ratings

| Parameter                                         | Symbol              | Condition                                 | Min                               | Max                     | Unit |
|---------------------------------------------------|---------------------|-------------------------------------------|-----------------------------------|-------------------------|------|
| Voltage at any supply pin                         |                     | V <sub>DD</sub> and V <sub>DDIO</sub> Pin | -0.3                              | 3.8                     | V    |
| Voltage at any interface pin                      |                     |                                           | V <sub>ss</sub> -0.3              | V <sub>DDIO</sub> + 0.3 | V    |
| Storage temperature                               |                     | ≤ 65% rel. H.                             | -45                               | +85                     | °C   |
| Overpressure survivability                        | P <sub>OVER</sub>   |                                           |                                   | 2 000 000               | Pa   |
| Mechanical shock                                  | M <sub>S</sub>      | MIL-STD-883H<br>2002.5                    |                                   | 12000                   | g    |
| Maximum allowable dust particle<br>inside package | Dust <sub>MAX</sub> | ISO 12103-1 A2                            |                                   | 300 <sup>5</sup>        | µm   |
| ESD                                               |                     | Charge device model<br>(CDM)              | Class<br>C2a:<br>500V to<br><750V |                         |      |
|                                                   |                     | Human body model<br>(HBM)                 | Class 2:<br>2 kV                  |                         |      |

Note: Stresses above these listed maximum ratings may cause permanent damage to the device. Exposure beyond specified electrical characteristics (Table 2) may affect device reliability or cause malfunction.

## 3. Functional description

The BMP388 consists of a Piezo-resistive pressure sensing element and a mixed-signal ASIC. The ASIC performs A/D conversions and provides the conversion results and sensor specific compensation data through a digital interface.

BMP388 provides highest flexibility to the designer and can be adapted to the requirements regarding accuracy, measurement time and power consumption by selecting from a high number of possible combinations of the sensor settings.

BMP388 can be operated in three power modes (see section 3.3):

sleep mode | normal mode | forced mode

In sleep mode, no measurements are performed. Normal mode comprises an automated perpetual cycling between an active measurement period and an inactive standby period. In forced mode, a single measurement is performed. When the measurement is finished, the sensor returns to sleep mode.

<sup>5</sup> Defined by hole size

A set of oversampling settings is available ranging from ultra-low power to highest resolution setting in order to adapt the sensor to the target application. The settings are predefined combinations of pressure measurement oversampling and temperature measurement oversampling. Pressure and temperature measurement oversampling can be selected independently from 0 to 32 times oversampling (see sections 3.4.1 and 3.4.2):

- Temperature measurement
- Ultra low power
- Low power
- Standard resolution
- High resolution
- Ultra high resolution
- Highest resolution

BMP388 is equipped with a built-in IIR filter in order to minimize short-term disturbances in the output data caused by the slamming of a door or window. The filter coefficient ranges from 0 (off) to 127.

### 3.1. Block diagram

Figure 1 shows a simplified block diagram of the BMP388:

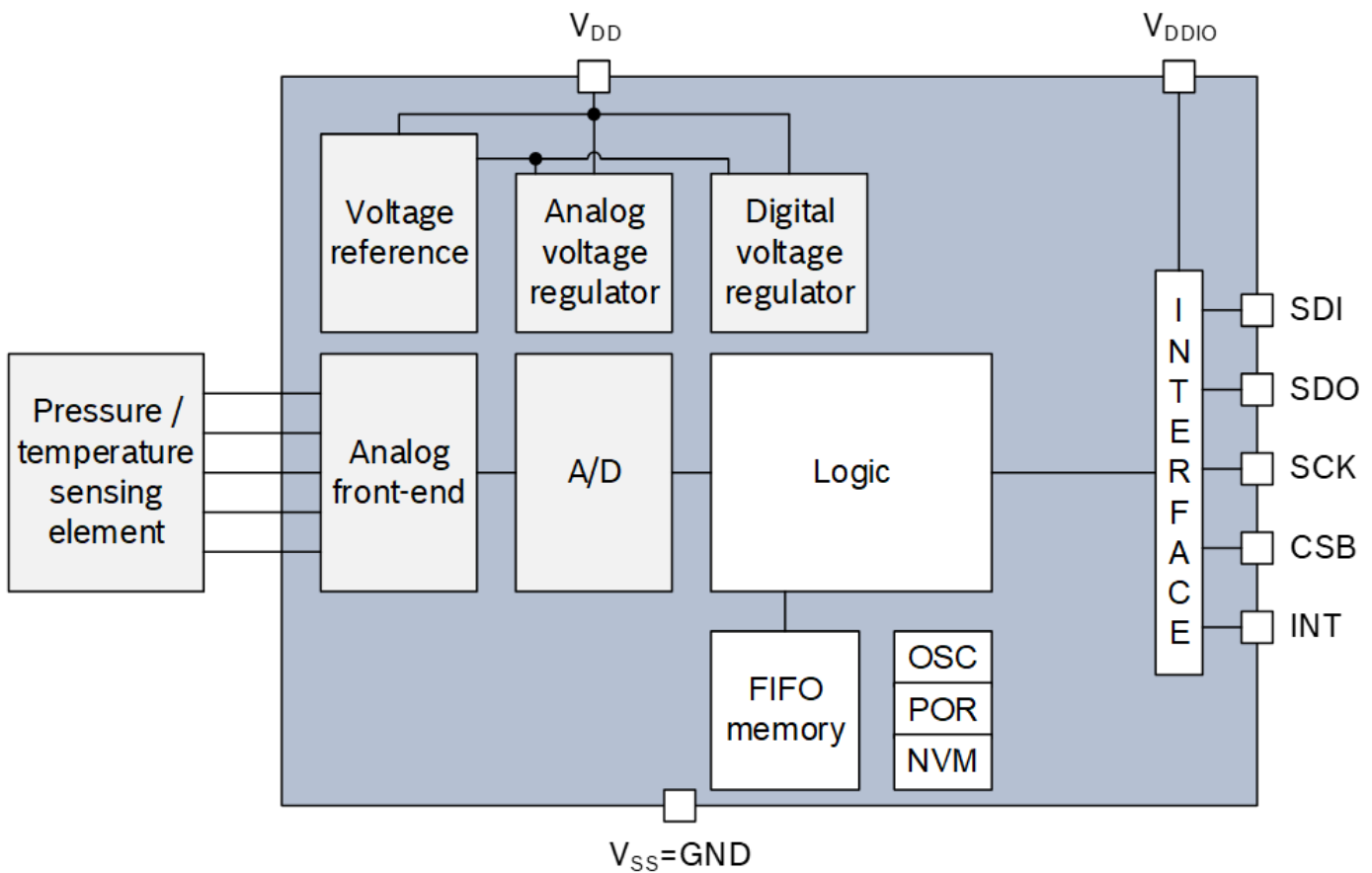


Figure 1: Block Diagram BMP388

### 3.2. Power management

The BMP388 has two separate power supply pins

- $V_{DD}$  is the main power supply for all internal analog and digital regulator blocks.
- $V_{DDIO}$  is a separate power supply pin, used for the supply of the digital interface.

$V_{DD}$  and  $V_{DDIO}$  pins can be energized in any order.

A power-on reset generator is built in which resets the logic circuitry and the register values after the power-on sequence. The slope for ramp up time must not be less than 10 ms. After powering up, the sensor settles in sleep mode (see section 3.3).

Completion of the power-on-reset or soft reset is indicated by the bit *por\_detected[0]*. The bit is cleared after reading.

Holding any interface pin (SDI, SDO, SCK or CSB) at a logical high level when  $V_{DDIO}$  is switched off can permanently damage the device due caused by excessive current flow through the ESD protection diodes.

### 3.3. Power modes

The BMP388 offers three power modes: sleep mode, forced mode and normal mode. These can be selected using the *mode[1:0]* bits in control register “*pwr\_ctrl*”.

Table 4: mode settings

| <i>mode[1:0]</i> | Mode        |
|------------------|-------------|
| 00               | Sleep mode  |
| 01 and 10        | Forced mode |
| 11               | Normal mode |

#### 3.3.1. Sleep mode

Sleep mode is set by default after power on reset. In sleep mode, no measurements are performed and power consumption ( $I_{DDSL}$ ) is at a minimum. All registers are accessible; Chip-ID and compensation coefficients can be read.

#### 3.3.2. Forced mode

In forced mode, a single measurement is performed according to selected measurement and filter options. When the measurement is finished, the sensor returns to sleep mode and the measurement results can be obtained from the data registers. For a next measurement, forced mode needs to be selected again. Forced mode is recommended for applications which require low sampling rate or host-based synchronization.

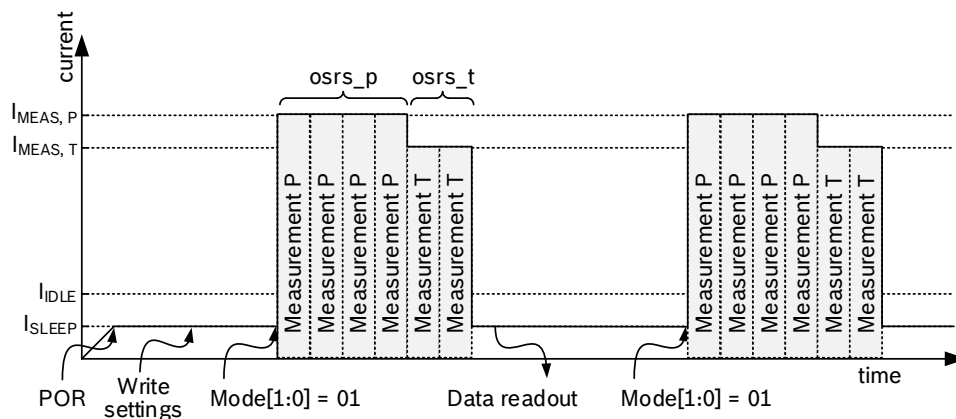


Figure 2: Force mode timing diagram

### 3.3.3. Normal mode

Normal mode continuously cycles between an (active) measurement period and an (inactive) standby period. The measurement rate is set in the *odr\_sel* register (see 4.3.17), where various prescaler for sample frequencies  $f_{\text{sampling}}=200\text{Hz}$  can be selected. The sampling period  $\tau$  calculated by

$$\tau_{\text{sampling}} = \text{prescaler} / f_{\text{sampling}}.$$

After setting the mode, measurement and filter options, the last measurement results can be obtained from the data registers without the need of further write accesses. Normal mode is recommended when using the IIR filter, and useful for applications in which short-term disturbances (e.g. blowing into the sensor) should be filtered.

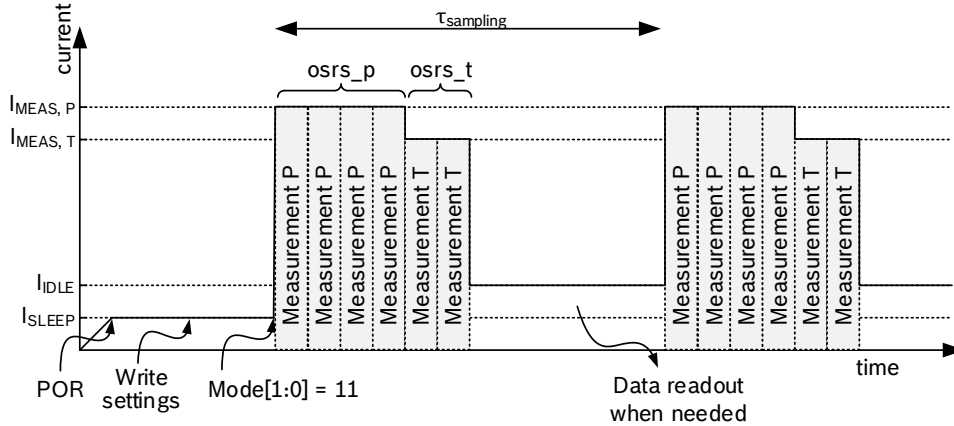


Figure 3: Normal mode timing diagram

### 3.3.4. Mode transition diagram

The supported mode transitions are displayed below. If the device is currently performing a measurement, execution of mode switching commands is delayed until the end of the currently running measurement period. Further mode change commands are ignored until the last mode change command is executed. Also, mode change commands that are not legal are ignored.

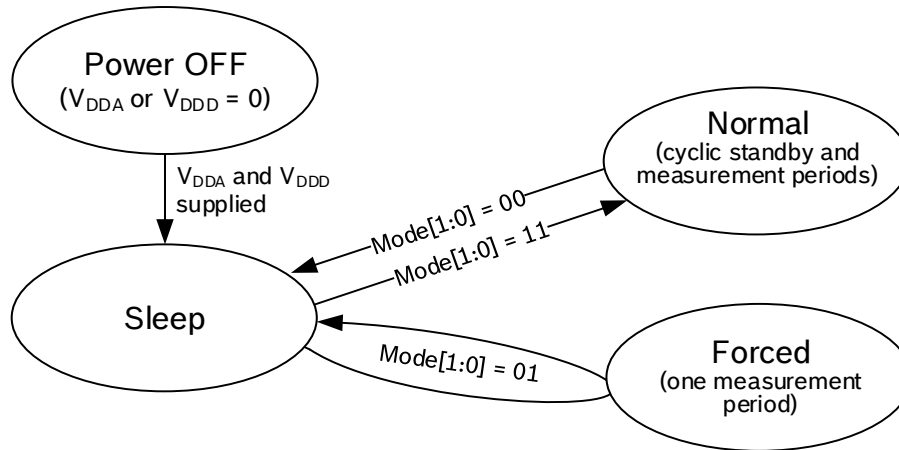


Figure 4: Mode transition diagram

### 3.4. Measurement flow

The BMP388 measurement period consists of a temperature and pressure measurement with selectable oversampling. After the measurement period, the data are passed through an optional IIR filter, which removes short-term fluctuations in pressure (e.g. caused by slamming a door). The flow is depicted in the diagram below.

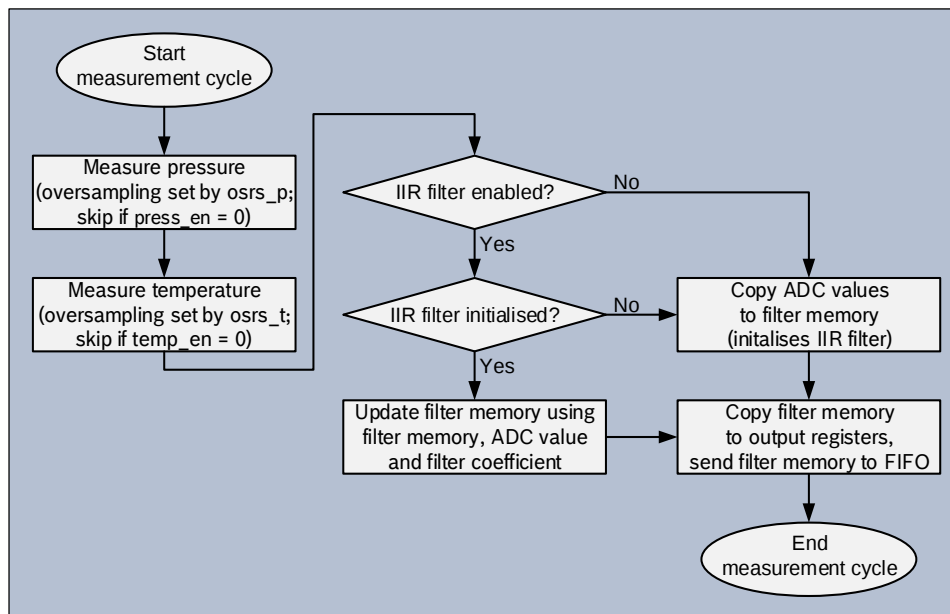


Figure 5: BMP388 measurement cycle

The individual blocks of the diagram above will be detailed in the following subsections.

### 3.4.1. Pressure measurement

Pressure measurement can be enabled or skipped. Skipping the measurement could be useful if BMP388 is used as temperature sensor. When enabled, several oversampling options exist. Each oversampling step reduces noise and increases the output resolution by one bit, which is stored in the XLSB data register.

Enabling the measurement is selected by `press_en` bit in “`PW_CTRL[0]`” register (see 4.3.15). The oversampling setting `osr_p` can be configured in “`OSR[2:0]`” register (see 4.3.16).

Table 5: `osr_p` settings

| Oversampling setting  | <code>osr_p</code> | Pressure oversampling | Typical pressure resolution | Recommended temperature oversampling |
|-----------------------|--------------------|-----------------------|-----------------------------|--------------------------------------|
| Ultra low power       | 000                | ×1                    | 16 bit / 2.64 Pa            | ×1                                   |
| Low power             | 001                | ×2                    | 17 bit / 1.32 Pa            | ×1                                   |
| Standard resolution   | 010                | ×4                    | 18 bit / 0.66 Pa            | ×1                                   |
| High resolution       | 011                | ×8                    | 19 bit / 0.33 Pa            | ×1                                   |
| Ultra high resolution | 100                | ×16                   | 20 bit / 0.17 Pa            | ×2                                   |
| Highest resolution    | 101                | ×32                   | 21 bit / 0.085 Pa           | ×2                                   |

### 3.4.2. Temperature measurement

Temperature measurement can be enabled or skipped. Skipping the measurement could be useful to measure pressure extremely rapidly. When enabled, several oversampling options exist. Each oversampling step reduces noise and increases the output resolution by one bit, which is stored in the XLSB data register. Noise and increases the output resolution by one bit, which is stored in the XLSB data register.

Enabling the measurement is selected by `temp_en` bit in “`PW_CTRL[1]`” register (see 4.3.15). The oversampling setting `osr_t` can be configured in “`OSR[5:3]`” register (see 4.3.16).

Table 6: `osrs_t` settings

| <code>osr_t</code> | Temperature oversampling | Typical temperature resolution |
|--------------------|--------------------------|--------------------------------|
| 000                | ×1                       | 16 bit / 0.0050 °C             |
| 001                | ×2                       | 17 bit / 0.0025 °C             |
| 010                | ×4                       | 18 bit / 0.0012 °C             |
| 011                | ×8                       | 19 bit / 0.0006 °C             |
| 100                | ×16                      | 20 bit / 0.0003 °C             |
| 101                | ×32                      | 21 bit / 0.00015 °C            |

It is recommended to base the value of `osr_t` on the selected value of `osrs_p` as per Table 5. Temperature oversampling above ×2 is possible, but will not significantly improve the accuracy of the pressure output any further. The reason for this is that the noise of the compensated pressure value depends more on the raw pressure than on the raw temperature noise. Following the recommended setting will result in an optimal noise-to-power ratio.

### 3.4.3. IIR filter

The environmental pressure is subject to many short-term changes, caused e.g. by slamming of a door or window, or wind blowing into the sensor. To suppress these disturbances in the output data without causing additional interface traffic and processor work load, the BMP388 features an internal IIR filter. It effectively reduces the bandwidth of the output signals<sup>6</sup>. The output of a next measurement step is filter using the following formula:

$$data_{filtered} = \frac{data_{filtered\_old} * filter\_coefficient + data_{ADC}}{filter\_coefficient + 1}$$

where  $data_{filtered\_old}$  is the data coming from the previous acquisition, and  $data_{ADC}$  is the data coming from the ADC before IIR filtering.

The IIR filter can be configured using setting *iir\_filter* in “CONFIG” register (see 4.3.18).

When writing to the register *filter*, the filter is reset. The next value will pass through the filter and be the initial memory value for the filter. IIR filter is reset if the temperature or pressure measurement is disabled (*temp\_en* or *press\_en* registers changed from ‘1’ to ‘0’) or when a transition from sleep mode to normal mode occurs. After enabling of pressure or temperature measurement, the filtering will start, thus the next incoming value will pass unfiltered and be the initial value of the IIR filter.

The step response (e.g. response to in sudden change in height) of different filter settings is displayed in Figure 6.

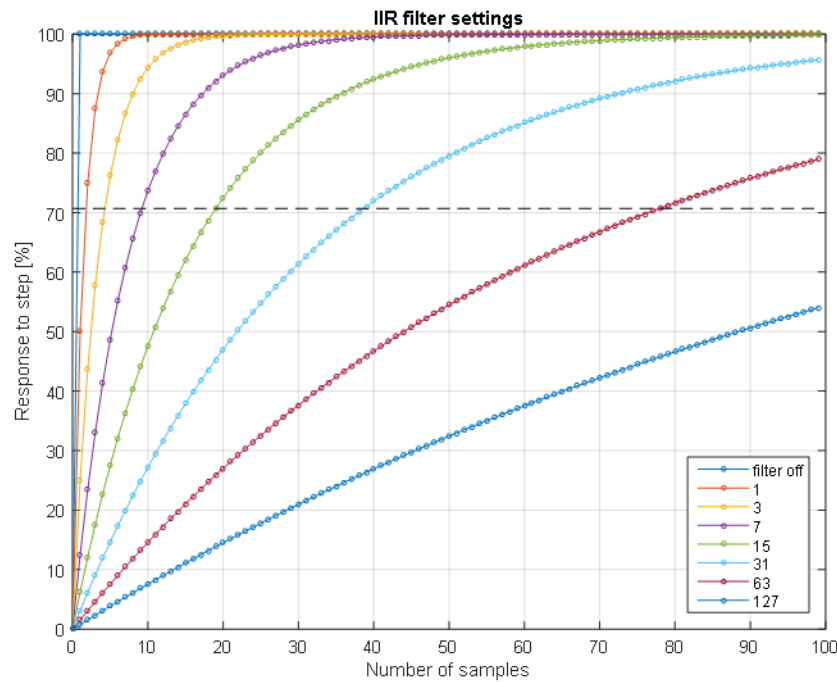


Figure 6: Step response at different IIR filter settings

### 3.4.4. Oversampling

Noise depends on the oversampling and filter settings selected. The stated values were determined in a controlled pressure environment and are based on the average standard deviation of 32 consecutive measurement points taken at highest sampling rate (for details please refer to Table 21). This is required to exclude long term drifts from the noise measurement.

<sup>6</sup> Since most pressure sensors do not sample continuously, filtering can suffer from signals with a frequency higher than the sampling rate of the sensor. E.g. environmental fluctuations caused by windows being opened and closed might have a frequency <5 Hz. Consequently, a sampling rate of ODR = 10 Hz is sufficient to obey the Nyquist theorem.

Table 7: Noise in pressure  
Typical RMS noise in pressure [Pa]

| Oversampling setting  | IIR filter coefficient |     |     |     |     |     |     |      |
|-----------------------|------------------------|-----|-----|-----|-----|-----|-----|------|
|                       | off                    | 2   | 4   | 8   | 16  | 32  | 64  | 128  |
| Ultra low power       | 6.6                    | 3.8 | 2.5 | 1.7 | 1.2 | 0.8 | 0.6 | 0.4  |
| Low power             | 4.3                    | 2.5 | 1.6 | 1.1 | 0.8 | 0.5 | 0.4 | 0.3  |
| Standard resolution   | 3.2                    | 1.8 | 1.2 | 0.8 | 0.6 | 0.4 | 0.3 | 0.2  |
| High resolution       | 2.3                    | 1.3 | 0.9 | 0.6 | 0.4 | 0.3 | 0.2 | 0.1  |
| Ultra high resolution | 1.6                    | 0.9 | 0.6 | 0.4 | 0.2 | 0.2 | 0.1 | 0.1  |
| Highest resolution    | 1.2                    | 0.7 | 0.4 | 0.3 | 0.3 | 0.1 | 0.1 | <0.1 |

Table 8: Noise in temperature  
Typical RMS noise in temperature [°C]

| Temperature oversampling | IIR filter off |
|--------------------------|----------------|
| Ultra low power          | 0.005          |
| Low power                | 0.005          |
| Standard resolution      | 0.005          |
| High resolution          | 0.005          |
| Ultra high resolution    | 0.004          |
| Highest resolution       | 0.003          |

### 3.5. Filter selection

In order to select optimal settings, the following use cases are suggested:

Table 9: Recommended filter settings based on use cases

| Use case                                    | Mode   | Over-sampling setting | osrs_p | osrs_t | IIR filter coeff.<br>(see 4.3.18) | I <sub>DD</sub> [μA]<br>(see 3.8) | ODR [Hz]<br>(see 3.4.1) | RMS Noise [cm]<br>(see 3.4.4) |
|---------------------------------------------|--------|-----------------------|--------|--------|-----------------------------------|-----------------------------------|-------------------------|-------------------------------|
| handheld device low-power<br>(e.g. Android) | Normal | High resolution       | x8     | x1     | 2                                 | 145                               | 12.5                    | 11                            |
| handheld device dynamic<br>(e.g. Android)   | Normal | Standard resolution   | x4     | x1     | 4                                 | 310                               | 50                      | 10                            |
| Weather monitoring<br>(lowest power),       | Forced | Ultra low power       | x1     | x1     | Off                               | 4                                 | 1/60                    | 55                            |
| Drop detection                              | Normal | Low power             | x2     | x1     | Off                               | 358                               | 100                     | 36                            |
| Indoor navigation                           | Normal | Ultra high resolution | x16    | x2     | 4                                 | 560                               | 25                      | 5                             |
| Drone                                       | Normal | Standard Resolution   | x8     | x1     | 2                                 | 570                               | 50                      | 11                            |

### 3.6. FIFO Description

The BMP388 contains a 512 Bytes FIFO (first-in-first-out) data buffer. To enable data collecting in the FIFO, *fifo\_mode* is set at '1' and data to be collected are defined through *fifo\_press\_en* and *fifo\_temp\_en*. The FIFO mode is disabled, when no writing is defined which according to the following two cases:

- *fifo\_mode*='0'
- *fifo\_mode*='1' and *fifo\_press\_en*='0' and *fifo\_temp\_en*='0'

If the FIFO is disabled when FIFO byte count is greater than 0, no new frame is written to the FIFO, but FIFO is operational:

- Frames already written in the FIFO remain stored and can be read out
- FIFO interrupts and their corresponding statuses are still evaluated
- after all bytes are read out, Sensortime (if enabled) and Empty frames are generated
- FIFO can be flushed

#### 3.6.1. FIFO input data

Storing of pressure and/or temperature measurement results is enabled by setting *fifo\_press\_en*='1' and *fifo\_temp\_en*='1' respectively. Storing of data can be enabled or disabled on a per-channel basis in any combination. Filtered or unfiltered data are stored to the FIFO; if *data\_select*="01", filtered data are stored, otherwise unfiltered data are stored to the FIFO. The Number of bytes available in FIFO is readable through *fifo\_length\_1*<0> (MSBs) and *fifo\_length\_0*<7:0> (LSBs) registers.

The FIFO byte count registers *fifo\_length\_0* and *fifo\_length\_1* are updated only when a full frame has been written to FIFO and is available for read-out. FIFO byte count registers are also updated after each full-frame read from the FIFO.

FIFO byte count registers increment or decrement is equal to frame length; intermediate increments (corresponding to a partial frame) are not readable.

#### 3.6.2. FIFO data sampling selection

The FIFO input data rate is reduced by selecting a down-sampling factor in register *fifo\_subsampling*. Down-sampling factor ranges from 1 to 128 and is equal to  $2^{\text{fifo\_subsampling}}$ . Down-sampling is applied in the normal mode only and is aligned to the measurement timing grid. Down-sampling counter is reset and data saved to the FIFO at the end of the first measurement when a transition from sleep mode to normal mode occurs.

#### 3.6.3. FIFO read out

FIFO is read out via *fifo\_data* register. FIFO reads are never blocked, however an ongoing read from the FIFO does not block writing to the FIFO.

During burst read, the address counter stops incrementing when *fifo\_data* address is reached; this allows a complete reading of the FIFO content within one burst read transaction.

### 3.6.4. FIFO overflow behavior

A FIFO overflow occurs if the FIFO is full and a new data is written to the FIFO. FIFO full means free space is less than maximum frame length (9 bytes). In case of overflow the FIFO can either stop recording data or overwrite the oldest data. The behavior is controlled by register `fifo_stop_on_full`.

- Streaming mode, `fifo_stop_on_full='0'`:  
if the new frame does not fit inside the remaining free space in the FIFO RAM, FIFO will repeatedly delete the oldest frame until it creates enough space for the new one.
- FIFO stop-on-full mode, `fifo_stop_on_full='1'`:  
The newest frame is discarded. Normal operation resumes if the FIFO full condition no longer persists.

### 3.6.5. FIFO Frames

One data frame is composed of a header and a set of data organize as described in table below.

Table 10: Data frame composition

| Bit    | 7 |              | 6 | 5             | 4 | 3 | 2 | 1 | 0 |
|--------|---|--------------|---|---------------|---|---|---|---|---|
| Header |   | fh_mode[1:0] |   | fh_param[3:0] |   |   |   | 0 | 0 |
| Data   |   | Data bytes   |   |               |   |   |   |   |   |

The number of data bytes is defined by the header.

#### 3.6.5.1. Header Format

Table 11: Header format

| fh_mode[1:0] | Definition                                     | fh_param[3:0]      |
|--------------|------------------------------------------------|--------------------|
| 10           | Sensor frame                                   | Sensor enable bits |
| 01           | Control frame: configuration error             | 0001               |
| 01           | Control frame: FIFO input configuration change | 0010               |

#### 3.6.5.2. Sensor Frame Format

A sensor frame consists of a header and data bytes

Table 12: Sensor frame format

| Bit    | 7          | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------|------------|---|---|---|---|---|---|---|
| Header | 1          | 0 | s | t | 0 | p | 0 | 0 |
| Data   | data bytes |   |   |   |   |   |   |   |

Sensor data in frame is defined by s (time), t (temperature) and p (pressure) sensor enable bits:

- If s='1', the frame corresponds to the sensor-time frame, in that case, t=p='0'
- If t='1' or/and p='1', the frame corresponds to a normal pressure or/and a temperature frame
- If s=t=p='0', the frame corresponds to an empty frame

Table 13: Sensor-time frame

| Bit         | 7              | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----------------|---|---|---|---|---|---|---|
| Header      | 1              | 0 | 1 | 0 | 0 | 0 | 0 | 0 |
| Sensor-time | time_xlsb[7:0] |   |   |   |   |   |   |   |
|             | time_lsb[7:0]  |   |   |   |   |   |   |   |
|             | time_msb[7:0]  |   |   |   |   |   |   |   |

The data for the sensor-time frame consists of register sensor\_time content at the time the sensortime frame transmission has started. A sensor-time frame is not stored in the FIFO, but append to every FIFO burst read operation after all data has been transmitted if fifo\_time\_en='1'.

Table 14: Normal pressure and temperature frame

| Bit    | 7               | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------|-----------------|---|---|---|---|---|---|---|
| Header | 1               | 0 | 0 | 1 | 0 | 1 | 0 | 0 |
| Temp   | temp_xlsb[7:0]  |   |   |   |   |   |   |   |
|        | temp_lsb[7:0]   |   |   |   |   |   |   |   |
|        | temp_msb[7:0]   |   |   |   |   |   |   |   |
| Press  | press_xlsb[7:0] |   |   |   |   |   |   |   |
|        | press_lsb[7:0]  |   |   |   |   |   |   |   |
|        | press_msb[7:0]  |   |   |   |   |   |   |   |

If one of t and p is '0', the corresponding data is not part of the frame; the frame is therefore reduced to 4 bytes.

A FIFO empty frame is a sensor frame with no sensor enabled. This frame is returned if the last frames was read-out or if FIFO is empty.

Table 15: FIFO empty frame format

| Bit    | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------|---|---|---|---|---|---|---|---|
| Header | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Data   | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

When a configuration error is detected, a configuration error frame is stored into the FIFO

Table 16: Control frame: configuration error

| Bit    | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------|---|---|---|---|---|---|---|---|
| Header | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0 |
| Opcode | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |

If FIFO is enabled and a change in registers "FIFO\_CONF\_2" or "OSR" or "ODR" or "CONFIG" or press\_en or temp\_en occurs, a control frame is inserted just before the first sensor frame with new configuration is stored to the FIFO. If multiple configuration change becomes active at the same time, only one control frame is inserted. Configuration changes are tracked when the device is in normal mode.

### 3.6.6. Corner cases

#### 3.6.6.1. Under-read

In case the FIFO is under-read (not all frames were taken from the FIFO, but the last frame read was read entirely), the next readout will continue at the frame that was just about to be sent.

#### 3.6.6.2. Partial frame read

In case the FIFO is under-read and a partial data frame read occurred (not all frames were taken from the FIFO, and the last frame read was not read entirely), the entire last data frame is repeated upon the next read access.

When `fifo_stop_on_full='0'`, the oldest frames are overwritten when new frames are available and the FIFO is full. When this happens, the partially read data frame is not repeated but the oldest frame available in the RAM is sent instead.

Sensortime frame is not repeated when read only partially, its payload always contains current sensortime counter value.

If the read of the frame is interrupted after two or more bits of the frame's last byte were already read, then frame is discarded even though not all bits were read and the frame was read only partially.

#### 3.6.6.3. Over-read

If the burst read continues after all frames have been read out, a sensortime frame is sent after the FIFO becomes empty during a burst read operation if `fifo_time_en='1'`. After that or when FIFO was completely read, the empty frame is returned as long as the burst read is

active.

### 3.6.7. FIFO flush conditions

The FIFO can be flushed by issuing either *fifo\_flush* or a *softreset* in the command register "CMD" (see 4.3.20):

Table 17: `fifo_flush` and `softreset` commands

|                         | Value |
|-------------------------|-------|
| <code>fifo_flush</code> | 0xB0  |
| <code>softreset</code>  | 0xB6  |

3.7. Interrupts

The BMP388 provides an interrupt pin (INT), which allows to signal certain events to the host processor. Different events can be mapped to the interrupt pin, which all are processed with a logical OR.

The available interrupts are listed below and can be read in the “INT\_STATUS” register (see 4.3.8):

- FIFO watermark interrupt
- FIFO full interrupt
- Data ready interrupt

3.7.1. Interrupt default mode

After a power-on or soft reset has completed, the interrupt pin is in push-pull and active high mode.

3.7.2. Interrupt pin latching

The chip can be operated in non-latched or latched mode:

- Non-latched mode: Interrupts’ conditions are selected as a contributors to the INT pad. INT pad is de-asserted as soon as the conditions of all the interrupts propagated to the INT pad are not valid.  
For data ready, interrupt contribution is de-asserted by reading *int\_status* or after 2.5ms after assertion of the interrupt.  
For FIFO interrupts, INT pad contributions are not affected by *fifo\_data* readings, only by the interrupt conditions
- Latched mode: Interrupt statuses are selected as contributors of the INT pad.

The minimum interrupt pulse width is  $T_{int} = 1\mu s$

3.7.3. Monitoring

The status of interrupt bits is always visible in the “INT\_STATUS” register. (see 4.3.8) for details.

3.7.4. Interrupt Pin Configuration

The interrupt pin / pad is configured by the Bits in the “INT\_CTRL” register (see 4.3.14). However, the status bits are not influenced thereby.

The output mode of the INT pad is controlled by *int\_od* bit:

Table 18: *int\_od*

|                    |            |
|--------------------|------------|
| <i>int_od</i> =’0’ | Push-pull  |
| <i>int_od</i> =’1’ | Open-drain |

The level of the interrupt pad can be configured and switched by *int\_level* between active low and active high:

Table 19: *int\_level*

|                       |             |
|-----------------------|-------------|
| <i>int_level</i> =’0’ | active_low  |
| <i>int_level</i> =’1’ | active_high |

The latching of interrupts for INT pad and INT\_STATUS register can be enabled by *int\_latch*=’1’ or disabled by *int\_latch*=’0’.

FIFO interrupts are mapped to the INT pad by enabling the respective functions. For mapping FIFO watermark reached interrupt to the pad, the *fwm\_en* bit shall be written to '1' (disabling by '0'). The FIFO full interrupt can be mapped by writing *ffull\_en* with '1'.

### 3.7.5. Interrupt functions

#### 3.7.5.1. FIFO watermark interrupt

The FIFO watermark interrupt is used to signal, that fill level of the FIFO has reached a pre-set limit.

$$\text{Fifo\_length\_1} \ \& \ \text{fifo\_length\_0} \ \geq \ \text{fifo\_wtm\_1} \ \& \ \text{fifo\_wtm\_0}$$

The watermark level can be set and adjusted by the user by writing the registers and 0x15 “FIFO\_WTM\_0” and 0x16 “FIFO\_WTM\_1” (see 4.3.11) in a single burst transaction. If the FIFO watermark level is set to zero, the interrupt condition will never be satisfied.

The status of the watermark interrupt can be read back through the *fwm\_int* bit. The interrupt condition is also updated after the end of a serial interface transaction which wrote into the registers *fifo\_wtm\_0* or *fifo\_wtm\_1*.

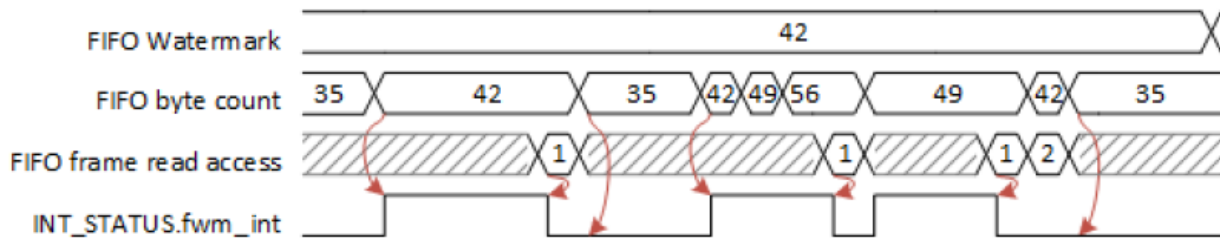


Figure 7: FIFO watermark interrupt, non-latched with reads from FIFO

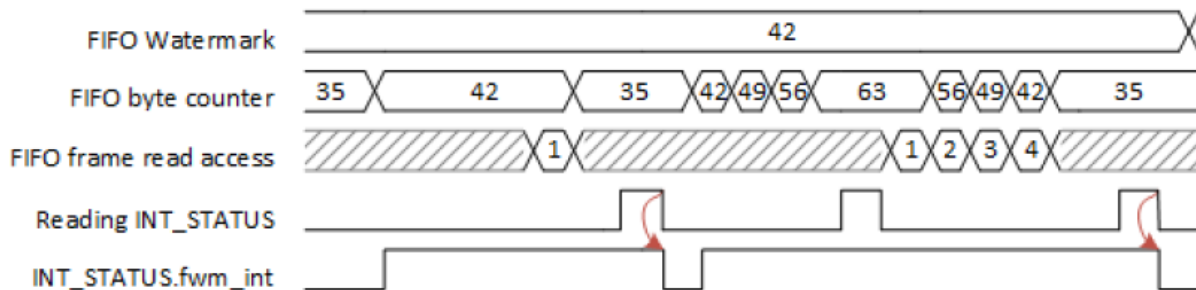


Figure 8: FIFO watermark interrupt, latched, with reads from FIFO

### 3.7.5.2. FIFO full interrupt

FIFO Full interrupt status is asserted when the full interrupt condition is satisfied, when the filling level of the FIFO number of unread bytes in the FIFO = *fifo\_length\_1* & *fifo\_length\_0* is equal or higher than 504.

The status of the FIFO full interrupt can be read back through the *ffull\_int* bit. Interrupt status is cleared by reading the *ffull\_int* bit high '1' when the FIFO filling level is lower than 504.

The FIFO full interrupt is propagated to INT pad only when it is enabled by setting bit *ffull\_en*='1'. Latching mode configuration bit *int\_latch* selects whether the interrupt status or condition is propagated to the INT pad.

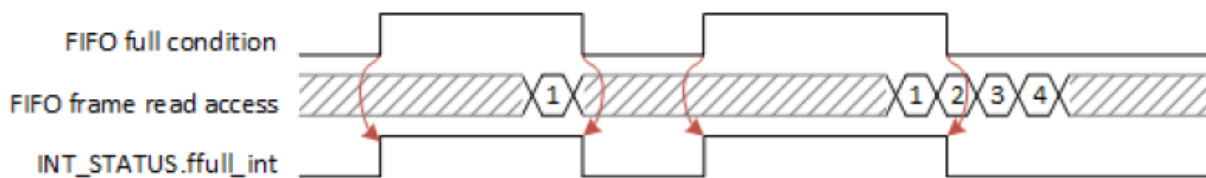


Figure 9: FIFO full interrupt, non-latched, with reads from FIFO

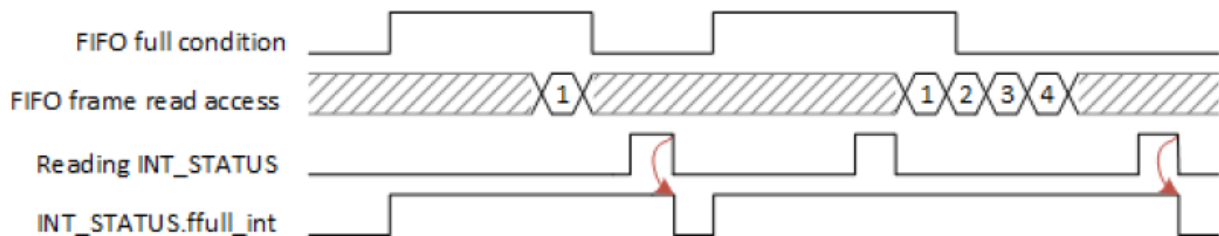


Figure 10: FIFO full interrupt, latched, with reads from FIFO

### 3.7.5.3. Data ready

Data ready interrupt status *int\_status.drdy* is asserted after a pressure and temperature measurement ends and conversion results are stored to the data registers and to the FIFO. The status of the interrupt can be read back through the *drdy* bit. The data ready interrupt is propagated to INT pad when it is enabled by setting *drdy\_en*='1'. Interrupt status is cleared by reading *drdy* bit high '1'. Data ready INT pad contribution is cleared automatically 2.5 ms after the interrupt assertion in the non-latched mode (*int\_latch*='0').

Corner cases:

- If data ready interrupt is changed from latched to non-latched mode (*int\_latched* changed from '1' to '0') after the interrupt was already asserted; timer is not running and it is not starting during the ongoing measurement, self-clearing does not happen. Timer is starting when next data ready comes.
- If data ready is changed to be propagated to INT pad (*drdy\_int* changed from '0' to '1') after the interrupt was already asserted; data ready INT pad contribution remains '0' until next data ready interrupt assertion.

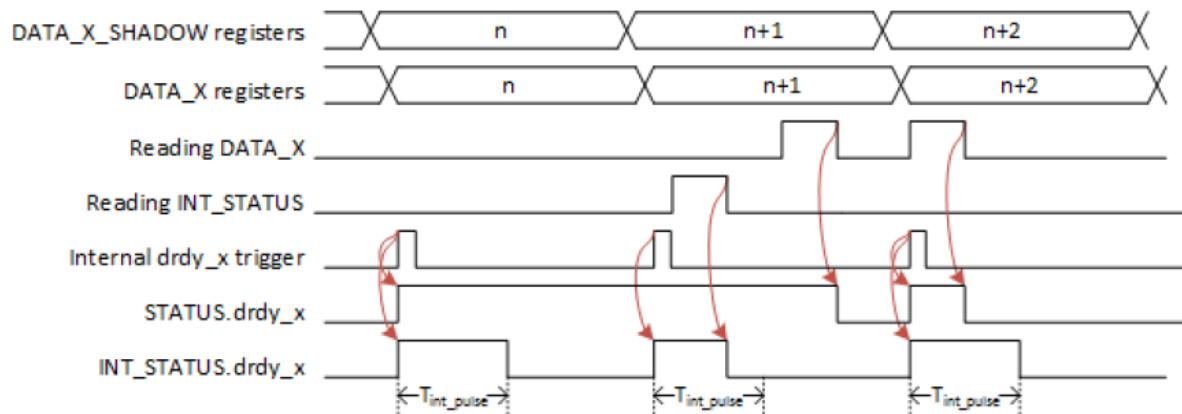


Figure 11: Data ready interrupt, non-latched mode, with read of data registers

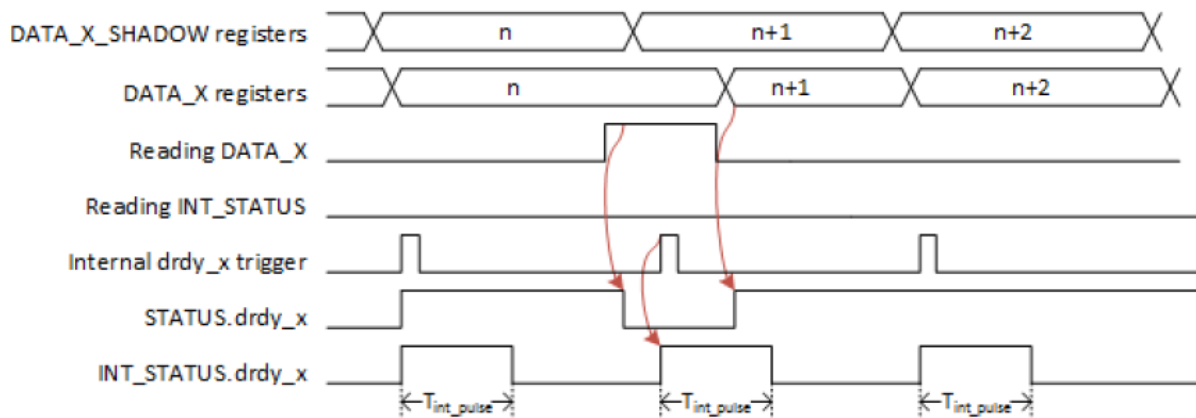


Figure 12: Data ready interrupt, non-latched mode, with read of data registers during register update

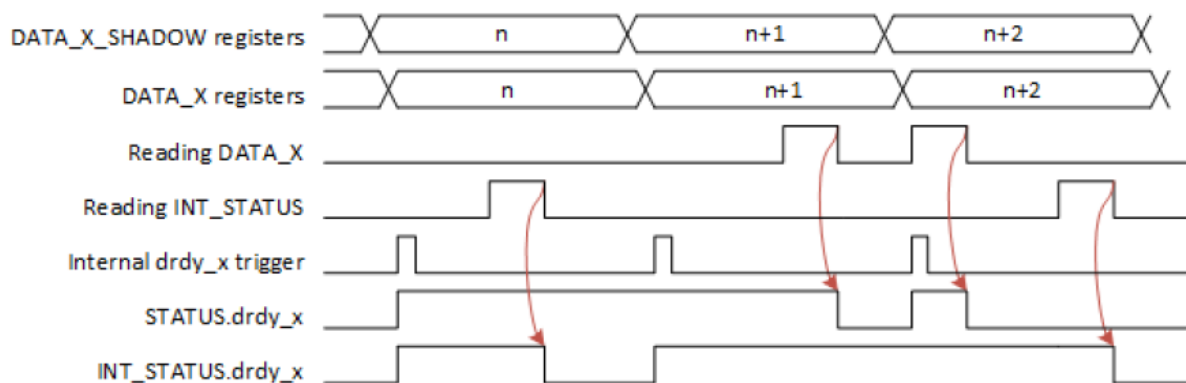


Figure 13: Data ready interrupt, latched mode, with read of data registers

### 3.8. Current consumption

The current consumption depends on ODR and oversampling setting. The values given below are normalized to an ODR of 1 Hz. The actual consumption at a given ODR can be calculated by multiplying the consumption in Table 20 with the ODR used. The actual ODR is defined either by the frequency at which the user sets forced measurements or by oversampling and sampling period settings in normal mode in Table 23.

Table 20: Current consumption

| Oversampling setting  | Pressure oversampling | Temperature oversampling | I <sub>DD</sub> [μA] @ 1 Hz forced mode |                        |      |
|-----------------------|-----------------------|--------------------------|-----------------------------------------|------------------------|------|
|                       |                       |                          | Typ                                     | Calculated Forced Mode | Max  |
| Ultra low power       | ×1                    | ×1                       | 3.4                                     | 4.3                    | 7.4  |
| Low power             | ×2                    | ×1                       | 4.8                                     | 5.6                    | 9.3  |
| Standard resolution   | ×4                    | ×1                       | 7.8                                     | 8.2                    | 12.8 |
| High resolution       | ×8                    | ×1                       | 13.8                                    | 13.3                   | 19.5 |
| Ultra high resolution | ×16                   | ×2                       | 26.2                                    | 24.3                   | 33.5 |
| highest resolution    | ×32                   | ×2                       | 46.4                                    | 45.0                   | 59.2 |

### 3.9. Measurement timings

The rate at which measurements can be performed in forced mode depends on the oversampling settings *osr\_t* and *osr\_p*. Thus in normal mode, the measurement rate is determined by the sampling frequency *fsample*.

#### 3.9.1. Measurement time

The following table explains the typical and maximum measurement time based on selected oversampling setting. The minimum achievable frequency is determined by the maximum measurement time.

Table 21: measurement time

| Oversampling setting  | Pressure oversampling | Temperature oversampling | Measurement time [ms] |      |                                    | Measurement rate [Hz] |       |                                    |
|-----------------------|-----------------------|--------------------------|-----------------------|------|------------------------------------|-----------------------|-------|------------------------------------|
|                       |                       |                          | Typ                   | Max  | calculated min time in forced mode | Typ                   | Min   | calculated max rate in forced mode |
| Ultra low power       | ×1                    | ×1                       | 5.5                   | 5.7  | 4.9                                | 181.8                 | 155.6 | 202                                |
| Low power             | ×2                    | ×1                       | 7.5                   | 8.7  | 6.9                                | 133.3                 | 114.6 | 144.1                              |
| Standard resolution   | ×4                    | ×1                       | 11.5                  | 13.3 | 10.9                               | 87.0                  | 75.0  | 91.4                               |
| High resolution       | ×8                    | ×1                       | 19.5                  | 22.5 | 18.9                               | 51.3                  | 44.4  | 52.8                               |
| Ultra high resolution | ×16                   | ×2                       | 37.5                  | 43.2 | 36.9                               | 26.7                  | 23.1  | 27.1                               |
| highest resolution    | ×32                   | ×2                       |                       |      | 68.9                               |                       |       | 14.5                               |

### 3.9.2. Measurement rate in forced mode and normal mode

In both forced mode and normal mode the pressure and temperature measurement duration follow the equation:

$$T_{conv} = 234\mu s + press\_en \cdot (392\mu s + 2^{osr\_p} \cdot 2000\mu s) + temp\_en \cdot (313\mu s + 2^{osr\_t} \cdot 2000\mu s)$$

With:

$T_{conv}$  = total conversion time in  $\mu s$

$press\_en$  = "0" or "1", depending of the status of the  $press\_en$  bit

$temp\_en$  = "0" or "1", depending of the status of the  $temp\_en$  bit

$2^{osr\_p}$  = amount of pressure oversampling repetitions

$2^{osr\_t}$  = amount of temperature oversampling repetitions

Maximum possible readout frequency in forced mode (typical):

$$f_{max} = \frac{1}{T_{conv}[\mu s] \cdot 10^6}$$

Maximum possible readout frequency in normal mode:

$$odr\_sel = \left\lceil \log_2 \left( \frac{200Hz}{f_{max}[Hz]} \right) \right\rceil$$

$$f_{max\_normal\_mode} = \frac{200Hz}{2^{odr\_sel}}$$

## 3.10. Data readout from data registers

To read out data after a conversion, it is strongly recommended to use a burst read and not address every register individually. This will prevent a possible mix-up of bytes belonging to different measurements and reduce interface traffic. Data readout is done by starting a burst read from register  $press\_xlsb$  to  $temp\_msb$ . The data are read out in an unsigned 24-bit format both for pressure and for temperature.

The timing for data readout in forced mode should be done so that the maximum measurement times (see Sec. 3.9.1) are respected. In normal mode, readout can be done at a speed similar to the expected data output rate (see Sec. 3.9.2). After the uncompensated values of temperature and pressure have been read, the actual pressure and temperature need to be calculated using the compensation parameters stored in the device. The procedure is elaborated in Sec. 3.11.

### 3.10.1. Data register shadowing

In normal mode, measurement timing is not necessarily synchronized to readout. This means that new measurement results may become available while the user is reading the results from the previous measurement. In this case, shadowing is performed in order to guarantee data consistency. Shadowing will only work if all data registers are read in a single burst read. Therefore, the user must use burst reads if he does not synchronize data readout with the measurement cycle. Using several independent read commands may result in inconsistent data.

If a new measurement is finished and the data registers are still being read, the new measurement results are transferred into shadow data registers. The content of shadow registers is transferred into data registers as soon as the user ends the burst read, even if not all data registers were read. Reading across several data registers can therefore only be guaranteed to be consistent within one measurement cycle if a single burst read command is used. The end of the burst read is marked by the rising edge of CSB pin. After the end of the burst read, all user data registers are updated at once.

### 3.11. Output compensation

The BMP388 output consists of the ADC output values (including oversampling). However, each sensing element behaves differently, and thus in order to receive the most accurate physical values for temperature and pressure, compensation formulae have to be applied to the raw output values received from the sensor. The coefficients used for the compensation are stored into the devices' non-volatile memory (NVM) during production (see Table 22). For the compensation formula please see Appendix 9.

#### 3.11.1. Memory Map Trimming Coefficients

Table 22: Trimming Coefficient listing in register map with size and sign attributes

| Memory-ADR_Read [dec] | Memory-ADR_Read [hex] | Register content | Trimming Coefficient | Size   | Sign     |
|-----------------------|-----------------------|------------------|----------------------|--------|----------|
| 69                    | 0x45                  | NVM_PAR_P11<7:0> | NVM_PAR_P11          | 8 Bit  | signed   |
| 68                    | 0x44                  | NVM_PAR_P10<7:0> | NVM_PAR_P10          | 8 Bit  | signed   |
| 67                    | 0x43                  | NVM_PAR_P9<15:8> | NVM_PAR_P9           | 16 Bit | signed   |
| 66                    | 0x42                  | NVM_PAR_P9<7:0>  |                      |        |          |
| 65                    | 0x41                  | NVM_PAR_P8<7:0>  | NVM_PAR_P8           | 8 Bit  | signed   |
| 64                    | 0x40                  | NVM_PAR_P7<7:0>  | NVM_PAR_P7           | 8 Bit  | signed   |
| 63                    | 0x3F                  | NVM_PAR_P6<15:8> | NVM_PAR_P6           | 16 Bit | unsigned |
| 62                    | 0x3E                  | NVM_PAR_P6<7:0>  |                      |        |          |
| 61                    | 0x3D                  | NVM_PAR_P5<15:8> | NVM_PAR_P5           | 16 Bit | unsigned |
| 60                    | 0x3C                  | NVM_PAR_P5<7:0>  |                      |        |          |
| 59                    | 0x3B                  | NVM_PAR_P4<7:0>  | NVM_PAR_P4           | 8 Bit  | signed   |
| 58                    | 0x3A                  | NVM_PAR_P3<7:0>  | NVM_PAR_P3           | 8 Bit  | signed   |
| 57                    | 0x39                  | NVM_PAR_P2<15:8> | NVM_PAR_P2           | 16 Bit | signed   |
| 56                    | 0x38                  | NVM_PAR_P2<7:0>  |                      |        |          |
| 55                    | 0x37                  | NVM_PAR_P1<15:8> | NVM_PAR_P1           | 16 Bit | signed   |
| 54                    | 0x36                  | NVM_PAR_P1<7:0>  |                      |        |          |
| 53                    | 0x35                  | NVM_PAR_T3<7:0>  | NVM_PAR_T3           | 8 Bit  | signed   |
| 52                    | 0x34                  | NVM_PAR_T2<15:8> | NVM_PAR_T2           | 16 Bit | unsigned |
| 51                    | 0x33                  | NVM_PAR_T2<7:0>  |                      |        |          |
| 50                    | 0x32                  | NVM_PAR_T1<15:8> | NVM_PAR_T1           | 16 Bit | unsigned |
| 49                    | 0x31                  | NVM_PAR_T1<7:0>  |                      |        |          |

## 4. Global memory map and register description

### 4.1. General remarks

All communication with the device is performed by reading and writing registers. All Registers have a width of 8 bits. There are several registers which are reserved; they should not be written to and no specific value is guaranteed when they are read. For details on the interface, consult chapter 5.

### 4.2. Datasheet Memory Map

The memory map is given in Table 23.

Table 23: BMP388 memory map

| read/write                  |                               |               | read only             |         |          | write only   |                |                  | reserved          |           |                     |
|-----------------------------|-------------------------------|---------------|-----------------------|---------|----------|--------------|----------------|------------------|-------------------|-----------|---------------------|
| Table 20: DM 660 memory map |                               |               |                       |         |          |              |                |                  |                   |           |                     |
| read/write                  |                               |               | read only             |         |          | write only   |                |                  | reserved          |           |                     |
| Register Address            | Register Name                 | Default Value | 7                     | 6       | 5        | 4            | 3              | 2                | 1                 | 0         |                     |
| 0x7E                        | <a href="#">CMD</a>           | 0x00          | cmd                   |         |          |              |                |                  |                   |           |                     |
| 0x7D                        | -                             | -             | reserved              |         |          |              |                |                  |                   |           |                     |
| ...                         | -                             | -             | reserved              |         |          |              |                |                  |                   |           |                     |
| 0x20                        | -                             | -             | reserved              |         |          |              |                |                  |                   |           |                     |
| 0x1F                        | <a href="#">CONFIG</a>        | 0x00          | reserved              |         |          |              | iir_filter     |                  |                   | reserved  |                     |
| 0x1E                        | -                             | -             | reserved              |         |          |              |                |                  |                   |           |                     |
| 0x1D                        | <a href="#">ODR</a>           | 0x00          | reserved              |         |          | odr_sel      |                |                  |                   |           |                     |
| 0x1C                        | <a href="#">OSR</a>           | 0x02          | reserved              |         | osr_t    |              |                | osr_p            |                   |           |                     |
| 0x1B                        | <a href="#">PWR_CTRL</a>      | 0x00          | reserved              |         | mode     |              | reserved       |                  | temp_en           | press_en  |                     |
| 0x1A                        | <a href="#">IF_CONFIG</a>     | 0x00          | reserved              |         |          |              |                | i2c_wdt_sel      | i2c_wdt_en        | spi3      |                     |
| 0x19                        | <a href="#">INT_CTRL</a>      | 0x02          | reserved              | drdy_en | reserved | ffull_en     | fwtm_en        | int_latch        | int_level         | int_od    |                     |
| 0x18                        | <a href="#">FIFO_CONFIG_2</a> | 0x02          | reserved              |         |          | data_select  |                | fifo_subsampling |                   |           |                     |
| 0x17                        | <a href="#">FIFO_CONFIG_1</a> | 0x02          | reserved              |         |          | fifo_temp_en | fifo_pre_ss_en | fifo_time_en     | fifo_stop_on_full | fifo_mode |                     |
| 0x16                        | <a href="#">FIFO_WTM_1</a>    | 0x00          | reserved              |         |          |              |                |                  |                   |           | fifo_water_mark_8   |
| 0x15                        | <a href="#">FIFO_WTM_0</a>    | 0x01          | fifo_water_mark_7_0   |         |          |              |                |                  |                   |           |                     |
| 0x14                        | <a href="#">FIFO_DATA</a>     | 0x00          | fifo_data             |         |          |              |                |                  |                   |           |                     |
| 0x13                        | <a href="#">FIFO_LENGTH_1</a> | 0x00          | reserved              |         |          |              |                |                  |                   |           | fifo_byte_counter_8 |
| 0x12                        | <a href="#">FIFO_LENGTH_0</a> | 0x00          | fifo_byte_counter_7_0 |         |          |              |                |                  |                   |           |                     |
| 0x11                        | <a href="#">INT_STATUS</a>    | 0x00          | reserved              |         |          |              | drdy           | reserved         | ffull_int         | fwm_int   |                     |
| 0x10                        | <a href="#">EVENT</a>         | 0x01          | reserved              |         |          |              |                |                  |                   |           | por_detected        |
| 0x0F                        | <a href="#">SENSOR_TIME_3</a> | 0x00          | sensor_time_31_24     |         |          |              |                |                  |                   |           |                     |
| 0x0E                        | <a href="#">SENSOR_TIME_2</a> | 0x00          | sensor_time_23_16     |         |          |              |                |                  |                   |           |                     |

|      |                                       |      |                  |           |            |         |             |          |         |           |
|------|---------------------------------------|------|------------------|-----------|------------|---------|-------------|----------|---------|-----------|
| 0x0D | <a href="#">SENSE<br/>RTIME<br/>1</a> | 0x00 | sensor_time_15_8 |           |            |         |             |          |         |           |
| 0x0C | <a href="#">SENSE<br/>RTIME<br/>0</a> | 0x00 | sensor_time_7_0  |           |            |         |             |          |         |           |
| 0x0B | -                                     | -    | reserved         |           |            |         |             |          |         |           |
| 0x0A | -                                     | -    | reserved         |           |            |         |             |          |         |           |
| 0x09 | <a href="#">DATA 5</a>                | 0x80 | temp_23_16       |           |            |         |             |          |         |           |
| 0x08 | <a href="#">DATA 4</a>                | 0x00 | temp_15_8        |           |            |         |             |          |         |           |
| 0x07 | <a href="#">DATA 3</a>                | 0x00 | temp_7_0         |           |            |         |             |          |         |           |
| 0x06 | <a href="#">DATA 2</a>                | 0x80 | press_23_16      |           |            |         |             |          |         |           |
| 0x05 | <a href="#">DATA 1</a>                | 0x00 | press_15_8       |           |            |         |             |          |         |           |
| 0x04 | <a href="#">DATA 0</a>                | 0x00 | press_7_0        |           |            |         |             |          |         |           |
| 0x03 | <a href="#">STATUS</a>                | 0x00 | reserved         | drdy_temp | drdy_press | cmd_rdy | reserved    |          |         |           |
| 0x02 | <a href="#">ERR_REG</a>               | 0x00 | reserved         |           |            |         |             | conf_err | cmd_err | fatal_err |
| 0x01 | -                                     | -    | reserved         |           |            |         |             |          |         |           |
| 0x00 | <a href="#">CHIP_ID</a>               | 0x50 | chip_id_fixed    |           |            |         | chip_id_nvm |          |         |           |

### 4.3. Register description

#### 4.3.1. Register 0x00 “CHIP\_ID”

The “CHIP\_ID” register contains the chip identification code.

Table 24: Register 0x00 “CHIP\_ID”

|          | Name | Description |
|----------|------|-------------|
| Bit 7..0 |      | Chip id.    |

#### 4.3.2. Register 0x02 “ERR\_REG”

Sensor Error conditions are reported in the “ERR\_REG” register.

Table 25: Register 0x02 “ERR\_REG”

|       | Name             | Description                                           |
|-------|------------------|-------------------------------------------------------|
| Bit 0 | <i>fatal_err</i> | Fatal error                                           |
| Bit 1 | <i>cmd_err</i>   | Command execution failed. Cleared on read.            |
| Bit 2 | <i>conf_err</i>  | sensor configuration error detected. Cleared on read. |

#### 4.3.3. Register 0x03 “STATUS”

The Sensor Status Flags are stored in the “STATUS” register.

Table 26: Register 0x03 “STATUS”

|       | Name              | Description                                                                                          |
|-------|-------------------|------------------------------------------------------------------------------------------------------|
| Bit 4 | <i>cmd_rdy</i>    | CMD decoder status.<br>0: Command in progress<br>1: Command decoder is ready to accept a new command |
| Bit 5 | <i>drdy_press</i> | Data ready for pressure.<br>It gets reset, when one pressure DATA register is read out               |
| Bit 6 | <i>drdy_temp</i>  | Data ready for temperature sensor.<br>It gets reset, when one temperature DATA register is read out  |

#### 4.3.4. Register 0x04 .. 0x06 Pressure Data

The 24Bit pressure data is split and stored in three consecutive registers

- 0x04 “DATA\_0”
- 0x05 “DATA\_1”
- 0x06 “DATA\_2”

Table 27: Pressure Data Registers

| Register | 0x06 DATA_2     | 0x05 DATA_1    | 0x04 DATA_0    |
|----------|-----------------|----------------|----------------|
| Bit      | 7..0            | 7..0           | 7..0           |
| name     | PRESS_MSB_23_16 | PRESS_LSB_15_8 | PRESS_XLSB_7_0 |
| Data     | pressure data   |                |                |

#### 4.3.5. Register 0x07 .. 0x09 Temperature Data

The 24Bit temperature data is split and stored in three consecutive registers

- 0x07 “DATA\_3”
- 0x08 “DATA\_4”
- 0x09 “DATA\_5”

Table 28: Temperature Data Registers

| Register | 0x09 DATA_5      | 0x08 DATA_4   | 0x07 DATA_3   |
|----------|------------------|---------------|---------------|
| Bit      | 7..0             | 7..0          | 7..0          |
| name     | TEMP_MSB_23_16   | TEMP_LSB_15_8 | TEMP_XLSB_7_0 |
| Data     | temperature data |               |               |

#### 4.3.6. Register 0x0C .. 0x0E Sensor Time

The 24Bit sensor time is split and stored in three consecutive registers

- 0x0C “SENSORTIME\_0”
- 0x0D “SENSORTIME\_1”
- 0x0E “SENSORTIME\_2”

Table 29: Sensor Time Registers

| Register | 0x0E SENSORTIME_2 | 0x0D SENSORTIME_1 | 0x0C SENSORTIME_0 |
|----------|-------------------|-------------------|-------------------|
| Bit      | 7..0              | 7..0              | 7..0              |
| name     | sensor_time_23_16 | sensor_time_15_8  | sensor_time_7_0   |
| Data     | Sensor time       |                   |                   |

#### 4.3.7. Register 0x10 “EVENT”

The “EVENT” register contains the sensor status flags.

Table 30: Register 0x10 “EVENT”

|       | Name                | Description                                           |
|-------|---------------------|-------------------------------------------------------|
| Bit 0 | <i>por_detected</i> | ‘1’ after device power up or softreset. Clear-on-read |

#### 4.3.8. Register 0x11 “INT\_STATUS”

The “INT\_STATUS” register shows interrupt status and is cleared after reading.

Table 31: Register 0x11 “INT\_STATUS”

|       | Name             | Description              |
|-------|------------------|--------------------------|
| Bit 0 | <i>fwm_int</i>   | FIFO Watermark Interrupt |
| Bit 1 | <i>ffull_int</i> | FIFO Full Interrupt      |
| Bit 3 | <i>drdy</i>      | data ready interrupt     |

#### 4.3.9. Register 0x12 .. 0x13 “FIFO\_LENGTH”

The FIFO byte counter indicates the current fill level of the FIFO buffer. Its size is 9 bit for 512 bytes and therefore split in two registers “FIFO\_LENGTH\_0” and “FIFO\_LENGTH\_1”.

Table 32: FIFO Length Split

| Register | 0x13 FIFO_LENGTH_1 |   |   |   |                     |   |   |   | 0x12 FIFO_LENGTH_0    |   |   |   |   |   |   |   |
|----------|--------------------|---|---|---|---------------------|---|---|---|-----------------------|---|---|---|---|---|---|---|
| Bit      | 7                  | 6 | 5 | 4 | 3                   | 2 | 1 | 0 | 7                     | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| name     |                    |   |   |   | fifo_byte_counter_8 |   |   |   | fifo_byte_counter_7_0 |   |   |   |   |   |   |   |

#### 4.3.10. Register 0x14 “FIFO\_DATA”

The “FIFO\_DATA” is the data output register.

Table 33: Register 0x14 “FIFO\_DATA”

|          | Name             | Description     |
|----------|------------------|-----------------|
| Bit 7..0 | <i>fifo_data</i> | FIFO read data. |

#### 4.3.11. Register 0x15 .. 0x16 FIFO Watermark

The FIFO Watermark size is 9 Bit and therefore written to the FIFO\_WTM\_0 and FIFO\_WTM\_1 registers.

Table 34: FIFO Watermark Register Overview

| Register | 0x16 FIFO_WTM_1   |   |   |   |   |   |   |   | 0x15 FIFO_WTM_0     |   |   |   |   |   |   |   |
|----------|-------------------|---|---|---|---|---|---|---|---------------------|---|---|---|---|---|---|---|
| Bit      | 7                 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 7                   | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| name     | fifo_water_mark_8 |   |   |   |   |   |   |   | fifo_water_mark_7_0 |   |   |   |   |   |   |   |

#### 4.3.12. Register 0x17 “FIFO\_CONFIG\_1”

The “FIFO\_CONFIG\_1” register contains the FIFO frame content configuration.

Table 35: Register 0x17 “FIFO\_CONFIG\_1”

|       | Name                     | Description                                                                                                                                                  |
|-------|--------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit 0 | <i>fifo_mode</i>         | Enables or disables the FIFO<br>0      disable<br>1      enable FIFO mode                                                                                    |
| Bit 1 | <i>fifo_stop_on_full</i> | Stop writing samples into FIFO when FIFO is full.<br>0      disable do not stop writing to FIFO when full<br>1      enable Stop writing into FIFO when full. |
| Bit 2 | <i>fifo_time_en</i>      | Return sensortime frame after the last valid data frame.<br>0      disable do not return sensortime frame<br>1      enable return sensortime frame           |
| Bit 3 | <i>fifo_press_en</i>     | Store pressure data in FIFO<br>0      disable no pressure data is stored<br>1      enable pressure data is stored                                            |
| Bit 4 | <i>fifo_temp_en</i>      | Store temperature data in FIFO<br>0      disable no temperature data is stored<br>1      enable temperature data is stored                                   |

#### 4.3.13. Register 0x18 “FIFO\_CONFIG\_2”

The “FIFO\_CONFIG\_2” register extends the FIFO\_CONFIG\_1 register.

Table 36: Register 0x18 “FIFO\_CONFIG\_2”

|          | Name                    | Description                                                                                                                                                                                                     |
|----------|-------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit 2..0 | <i>fifo_subsampling</i> | FIFO downsampling selection for pressure and temperature data, factor is $2^{\text{fifo\_subsampling}}$                                                                                                         |
| Bit 4..3 | <i>data_select</i>      | for pressure and temperature, select data source<br>0        unfiltered data (compensated or uncompensated)<br>1        filtered data (compensated or uncompensated)<br>01 10    reserved, same as for “unfilt” |

#### 4.3.14. Register 0x19 “INT\_CTRL”

Interrupt configuration can be set in the “INT\_CTRL” register. It affects INT\_STATUS registers and the INT pin.

Table 37: Register 0x19 “INT\_CTRL”

|       | Name             | Description                                                                                                            |
|-------|------------------|------------------------------------------------------------------------------------------------------------------------|
| Bit 0 | <i>int_od</i>    | Configure output: open-drain or push-pull<br>0        push-pull<br>1        open-drain                                 |
| Bit 1 | <i>int_level</i> | level of INT pin<br>0        active_low<br>1        active_high                                                        |
| Bit 2 | <i>int_latch</i> | Latching of interrupts for INT pin and INT_STATUS register<br>0        disabled<br>1        enabled                    |
| Bit 3 | <i>fwtm_en</i>   | enable FIFO watermark reached interrupt for INT pin and INT_STATUS.<br>0        disabled<br>1        enabled           |
| Bit 4 | <i>ffull_en</i>  | enable Fifo full interrupt for INT pin and INT_STATUS<br>0        disabled<br>1        enabled                         |
| Bit 6 | <i>drdy_en</i>   | enable temperature / pressure data ready interrupt for INT pin and INT_STATUS<br>0        disabled<br>1        enabled |

The “IF\_CONF” register controls the the serial interface settings.

Table 38: Register 0x1A “IF\_CONF”

|       | Name               | Description                                                                                                                                                               |
|-------|--------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit 0 | <i>spi3</i>        | Configure SPI Interface Mode for primary interface<br>0      spi4      SPI 4-wire mode<br>1      spi3      SPI 3-wire mode                                                |
| Bit 1 | <i>i2c_wdt_en</i>  | Enable for the I2C Watchdog timer, backed by NVM<br>0      disabled      Watchdog disabled<br>1      enabled      Watchdog enabled                                        |
| Bit 2 | <i>i2c_wdt_sel</i> | Select timer period for I2C Watchdog , backed by NVM<br>0      wdt_short      I2C watchdog timeout after 1.25 ms<br>1      wdt_long      I2C watchdog timeout after 40 ms |

#### 4.3.15. Register 0x1B “PWR\_CTRL”

The “PWR\_CTRL” register enables or disables pressure and temperature measurement. Although, the measurement mode can be set here.

Table 39: Register 0x1B “PWR\_CTRL”

|          | Name            | Description                                                                                                  |
|----------|-----------------|--------------------------------------------------------------------------------------------------------------|
| Bit 0    | <i>press_en</i> | 0      press_off      Disables the pressure sensor.<br>1      press_on      Enables the pressure sensor.     |
| Bit 1    | <i>temp_en</i>  | 0      temp_off      Disables the temperature sensor.<br>1      temp_on      Enables the temperature sensor. |
| Bit 5..4 | <i>mode</i>     | 0      sleep mode<br>01/01      forced mode<br>11      normal mode                                           |

#### 4.3.16. Register 0x1C “OSR”

The “OSR” register controls the oversampling settings for pressure and temperature measurements.

Table 40: Register 0x1C “OSR”

|          | Name          | Description                                                                                                                                                                                                     |
|----------|---------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit 2..0 | <i>osr_p</i>  | Oversampling setting pressure measurement<br>000 x1 no oversampling.<br>001 x2 x2 oversampling.<br>010 x4 x4 oversampling.<br>011 x8 x8 oversampling.<br>100 x16 x16 oversampling.<br>101 x32 x32 oversampling. |
| Bit 5..3 | <i>osr4_t</i> | Oversampling setting temperature measurement<br>000 x1 no oversampling<br>001 x2 x2 oversampling<br>010 x4 x4 oversampling<br>011 x8 x8 oversampling<br>100 x16 x16 oversampling<br>101 x32 x32 oversampling    |

#### 4.3.17. Register 0x1D “ODR”

The “ODR” register set the configuration of the output data rates by means of setting the 36ubdivision/subsampling.

Table 41: Register 0x1D “ODR”

|          | Name           | Description                                                                                                                                      |
|----------|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit 4..0 | <i>odr_sel</i> | subdivision factor for pressure and temperature measurements is $2^{\text{value}}$ . Allowed values are 0..17. Other values are saturated at 17. |

Table 42: Control Settings settings for *odr\_sel*

| <i>odr_sel</i> | prescaler | Name       | Description    | Sampling Period |
|----------------|-----------|------------|----------------|-----------------|
| 0x00           | 1         | ODR_200    | ODR 200Hz      | 5 ms            |
| 0x01           | 2         | ODR_100    | ODR 100Hz      | 10 ms           |
| 0x02           | 4         | ODR_50     | ODR 50Hz       | 20 ms           |
| 0x03           | 8         | ODR_25     | ODR 25Hz       | 40 ms           |
| 0x04           | 16        | ODR_12p5   | ODR 25/2Hz     | 80 ms           |
| 0x05           | 32        | ODR_6p25   | ODR 25/4Hz     | 160 ms          |
| 0x06           | 64        | ODR_3p1    | ODR 25/8Hz     | 320 ms          |
| 0x07           | 127       | ODR_1p5    | ODR 25/16Hz    | 640 ms          |
| 0x08           | 256       | ODR_0p78   | ODR 25/32Hz    | 1.280 s         |
| 0x09           | 512       | ODR_0p39   | ODR 25/64Hz    | 2.560 s         |
| 0x0A           | 1024      | ODR_0p2    | ODR 25/128Hz   | 5.120 s         |
| 0x0B           | 2048      | ODR_0p1    | ODR 25/256Hz   | 10.24 s         |
| 0x0C           | 4096      | ODR_0p05   | ODR 25/512Hz   | 20.48 s         |
| 0x0D           | 8192      | ODR_0p02   | ODR 25/1024Hz  | 40.96 s         |
| 0x0E           | 16384     | ODR_0p01   | ODR 25/2048Hz  | 81.92 s         |
| 0x0F           | 32768     | ODR_0p006  | ODR 25/4096Hz  | 163.84 s        |
| 0x10           | 65536     | ODR_0p003  | ODR 25/8192Hz  | 327.68 s        |
| 0x11           | 131072    | ODR_0p0015 | ODR 25/16384Hz | 655.36 s        |

#### 4.3.18. Register 0x1F “CONFIG”

The “CONFIG” register controls the IIR filter coefficients.

Table 43: Register 0x1F “CONFIG”

|          | Name              | Description                                             |
|----------|-------------------|---------------------------------------------------------|
| Bit 3..1 | <i>iir_filter</i> | filter coefficient for IIR filter                       |
|          |                   | 000    coef_0    filter coefficient is 0 -> bypass-mode |
|          |                   | 001    coef_1    filter coefficient is 1                |
|          |                   | 010    coef_3    filter coefficient is 3                |
|          |                   | 011    coef_7    filter coefficient is 7                |
|          |                   | 100    coef_15   filter coefficient is 15               |
|          |                   | 101    coef_31   filter coefficient is 31               |
|          |                   | 110    coef_63   filter coefficient is 63               |
|          |                   | 111    coef_127   filter coefficient is 127             |

#### 4.3.19. Register 0x30 .. 0x57 “calibration data”

The overview over the calibration data can be found in Chapter 3.11.1.

#### 4.3.20. Register 0x7E “CMD”

The available commands of the “CMD” register are listed below.

Table 44: Register 0x7E “CMD”

|          | Name       | Description                                                         |
|----------|------------|---------------------------------------------------------------------|
| Bit 7..0 | <i>cmd</i> | All Available commands<br>(Note: Register will always read as 0x00) |

Table 45: available cmd commands listed below

| Value | Name              | Description                                                                                |
|-------|-------------------|--------------------------------------------------------------------------------------------|
| 0x00  | nop               | reserved. No command.                                                                      |
| 0x34  | extmode_en_middle | see extmode_en_last                                                                        |
| 0xB0  | fifo_flush        | Clears all data in the FIFO, does not change FIFO_CONFIG registers                         |
| 0xB6  | softreset         | Triggers a reset, all user configuration settings are overwritten with their default state |

## 5. Digital interfaces

The BMP388 supports the I<sup>2</sup>C and SPI digital interfaces; it acts as a slave for both protocols. The I<sup>2</sup>C interface supports the standard, fast and high speed modes. The SPI interface supports both SPI mode '00' (CPOL = CPHA = '0') and mode '11' (CPOL = CPHA = '1') in 4-wire and 3-wire configuration.

The following transactions are supported:

- Single byte write
- Multiple byte write (using pairs of register addresses and register data)
- Single byte read
- Multiple byte read (using a single register address which is auto-incremented)

### 5.1. Interface selection

Interface selection is done automatically based on CSB (chip select) status. If CSB is connected to V<sub>DDIO</sub>, the I<sup>2</sup>C interface is active. If CSB is pulled down, the SPI interface is activated. After CSB has been pulled down once (regardless of whether any clock cycle occurred), the I<sup>2</sup>C interface is disabled until the next power-on-reset. This is done in order to avoid inadvertently decoding SPI traffic to another slave as I<sup>2</sup>C data. Since power-on-reset is only executed when both V<sub>DD</sub> and V<sub>DDIO</sub> are established, there is no risk of incorrect protocol detection due to power-up sequence used. However, if I<sup>2</sup>C is to be used and CSB is not directly connected to V<sub>DDIO</sub> but rather through a programmable pin, it must be ensured that this pin already outputs the V<sub>DDIO</sub> level during power-on-reset of the device. If this is not the case, the device will be locked in SPI mode and not respond to I<sup>2</sup>C commands.

### 5.2. I<sup>2</sup>C Interface

The I<sup>2</sup>C slave interface is compatible with Philips I<sup>2</sup>C Specification Revision 6 (April 2014). For detailed timings refer to Table 47. All modes (standard, fast, high speed) are supported. SDA and SCL are not pure open-drain. Both pads contain ESD protection diodes to V<sub>DDIO</sub> and GND.

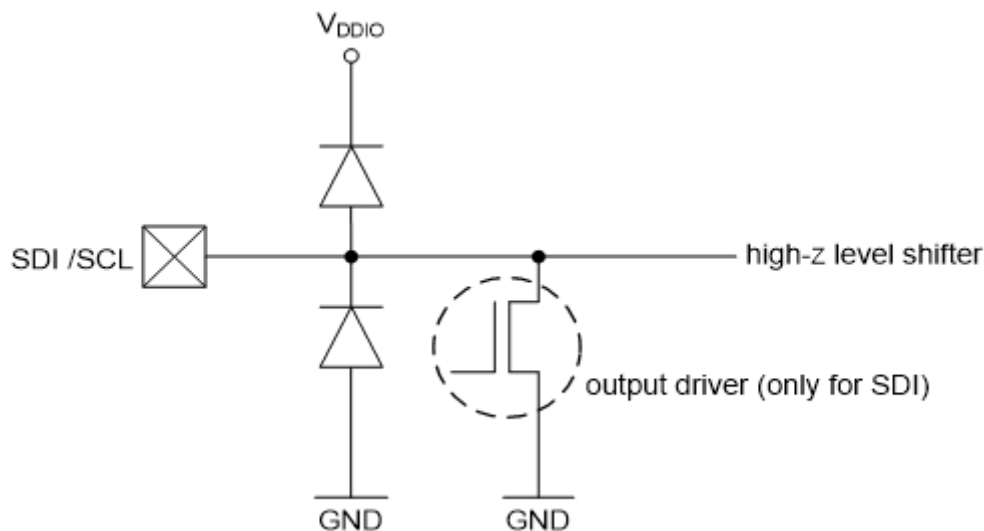


Figure 14: SDI/SCK ESD drawing

The 7-bit device address is 111011x. The 6 MSB bits are fixed. The last bit is changeable by SDO value and can be changed during operation. Connecting SDO to GND results in slave address 1110110 (0x76); connection it to V<sub>DDIO</sub> results in slave address 1110111 (0x77), which is the same as BMP180's I<sup>2</sup>C address. The SDO pin cannot be left floating; if left floating, the I<sup>2</sup>C address will be undefined.



### 5.3. SPI interface

The SPI interface is compatible with SPI mode '00' (CPOL = CPHA = '0') and mode '11' (CPOL = CPHA = '1'). The automatic selection between mode '00' and '11' is determined by the value of SCK after the CSB falling edge.

The SPI interface has two modes: 4-wire and 3-wire. The protocol is the same for both. The 3-wire mode is selected by setting *spi3*='1' in register "IF\_CONF[0]" (see 4.3.13). The pad SDI is used as a data input/output pad in 3-wire mode.

The SPI interface uses the following pins:

- CSB: chip select, active low
- SCK: serial clock
- SDI: serial data input; data input/output in 3-wire mode
- SDO: serial data output; hi-Z in 3-wire mode

Refer to chapter 6 for connection instructions.

CSB is active low and has an integrated pull-up resistor. Data on SDI is latched by the device at SCK rising edge and SDO is changed at SCK falling edge. Communication starts when CSB goes to low and stops when CSB goes to high; during these transitions on CSB, SCK must be stable. The SPI protocol is shown in Figure 17.

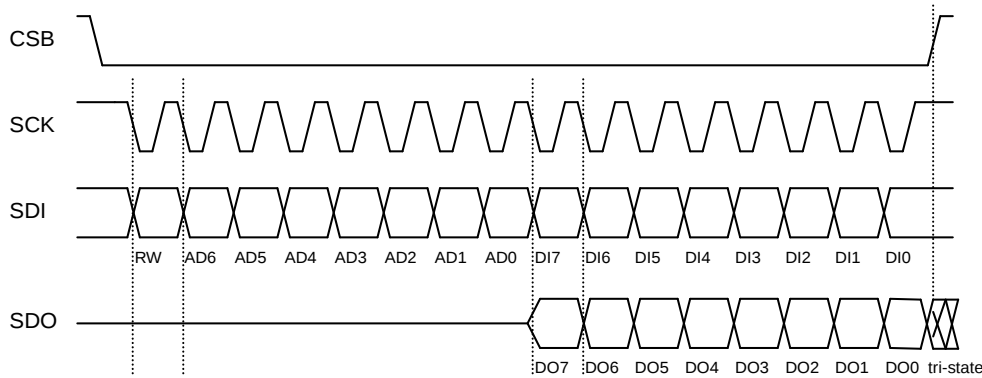


Figure 17: SPI protocol (shown for mode '11' in 4-wire configuration)

In SPI mode, only 7 bits of the register addresses are used; the MSB of register address is not used and replaced by a read/write bit (RW = '0' for write and RW = '1' for read).

Example: address 0xF7 is accessed by using SPI register address 0x77. For write access, the byte 0x77 is transferred, for read access, the byte 0xF7 is transferred.

#### 5.3.1. SPI write

Writing is done by lowering CSB and sending pairs control bytes and register data. The control bytes consist of the SPI register address (= full register address without bit 7) and the write command (bit7 = RW = '0'). Several pairs can be written without raising CSB. The transaction is ended by a raising CSB. The SPI write protocol is depicted in Figure 18.

Figure 18: 4 wire SPI sequence

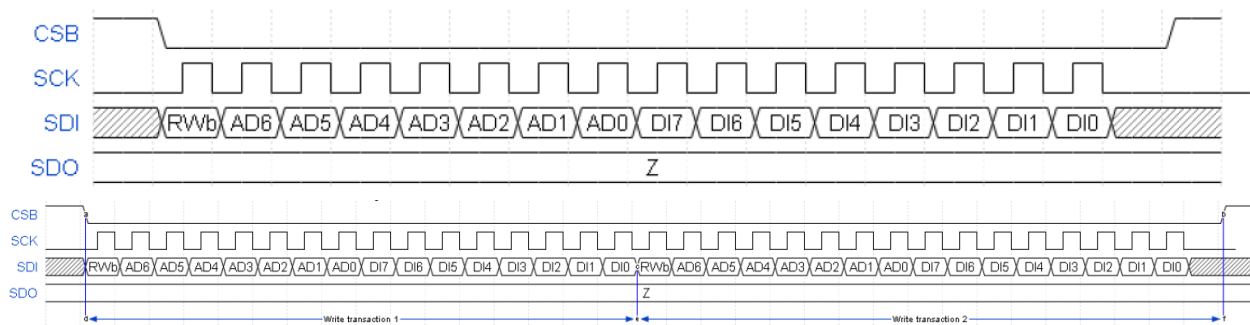


Figure 19: SPI multiple write

### 5.3.2. SPI read

Reading is done by lowering CSB and first sending one control byte. The control bytes consist of the SPI register address (= full register address without bit 7) and the read command (bit 7 = RW = '1'). After writing the control byte, one dummy byte is sent and there after data bytes. The register address is automatically incremented. The SPI read protocol is shown in Figure 20.

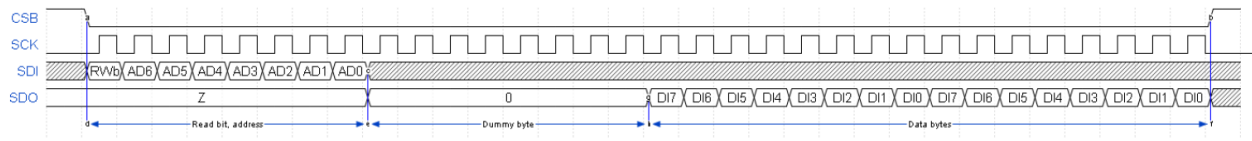


Figure 20: SPI multiple byte read

## 5.4. Interface parameter specification

### 5.4.1. General interface parameters

The general interface parameters are given in the table below:

Table 46: interface parameters

| Parameter                           | Symbol | Condition                                           | Min                    | Typ | Max                    | Units |
|-------------------------------------|--------|-----------------------------------------------------|------------------------|-----|------------------------|-------|
| Input – low level                   | Vil    | SCK, SDI and CSB                                    |                        |     | 0<br>V <sub>DDIO</sub> | V     |
| Input – high level                  | Vih    | SCK, SDI and CSB                                    | 1<br>V <sub>DDIO</sub> |     |                        | V     |
| Output – low level                  | Vol    | SDI, SDO and INT,<br>iol=3 mA                       |                        |     | 2<br>V <sub>DDIO</sub> | V     |
| Output – high level                 | Voh    | SDI, SDO and INT<br>ioh=1 mA                        | 3<br>V <sub>DDIO</sub> |     |                        | V     |
| CSB Pull-up resistor                | Rcsb   | Internal pull-up<br>resistance to V <sub>DDIO</sub> | 75                     | 100 | 125                    | kΩ    |
| I <sup>2</sup> C bus load capacitor | Cb     | On SDI and SCK                                      |                        |     | 400                    | pF    |

### 5.4.2. I<sup>2</sup>C timings

For I<sup>2</sup>C timings, the following abbreviations are used:

- “S&F mode” = standard and fast mode
- “HS mode” = high speed mode
- Cb = bus capacitance on SDA line

All other naming refers to I<sup>2</sup>C specification 2.1 (January 2000).

The I<sup>2</sup>C timing diagram is shown in

Figure 21. The corresponding values are given in Table 47.

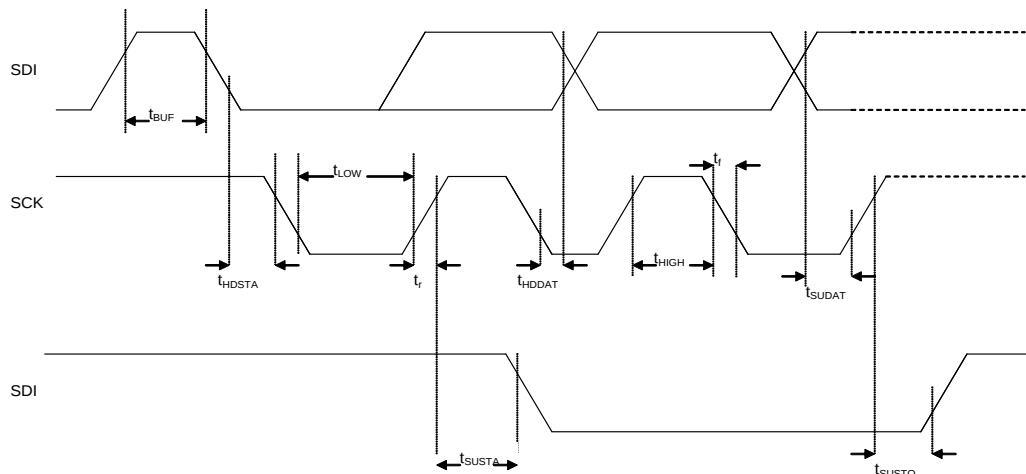


Figure 21: I²C timing diagram

Table 47: I²C timings

| Parameter            | Symbol       | Condition                                         | Min | Typ | Max  | Units |
|----------------------|--------------|---------------------------------------------------|-----|-----|------|-------|
| SCK frequency        | Fi2c         |                                                   |     | 400 | 3400 | kHz   |
| SDI input setup time | $t_{SU,DAT}$ | S&F Mode                                          | 160 |     |      | ns    |
|                      |              | HS mode                                           | 30  |     |      | ns    |
| SDI output hold time | $t_{HD,DAT}$ | S&F Mode, $C_b \leq 100$ pF                       | 80  |     |      | ns    |
|                      |              | S&F Mode, $C_b \leq 400$ pF                       | 90  |     |      | ns    |
|                      |              | HS mode, $C_b \leq 100$ pF                        | 18  |     |      | ns    |
|                      |              | HS mode, $C_b \leq 400$ pF                        | 24  |     |      | ns    |
| SCK low pulse        | $t_{LOW}$    | HS mode, $C_b \leq 100$ pF<br>$V_{DDIO} = 1.62$ V | 160 |     |      | ns    |
| SCK low pulse        | $t_{LOW}$    | HS mode, $C_b \leq 100$ pF<br>$V_{DDIO} = 1.2$ V  | 210 |     |      | ns    |

The above-mentioned I²C specific timings correspond to the following internal added delays:

- Input delay between SDI and SCK inputs: SDI is more delayed than SCK by typically 120 ns in Standard and Fast Modes and by typically 20 ns in High Speed Mode.
- Output delay from SCK falling edge to SDI output propagation is typically 140 ns in Standard and Fast Modes and typically 70 ns in High Speed Mode.

### 5.4.3. SPI timings

The SPI timing diagram is in Figure 22, while the corresponding values are given in Table 48. All timings apply both to 4- and 3-wire SPI.

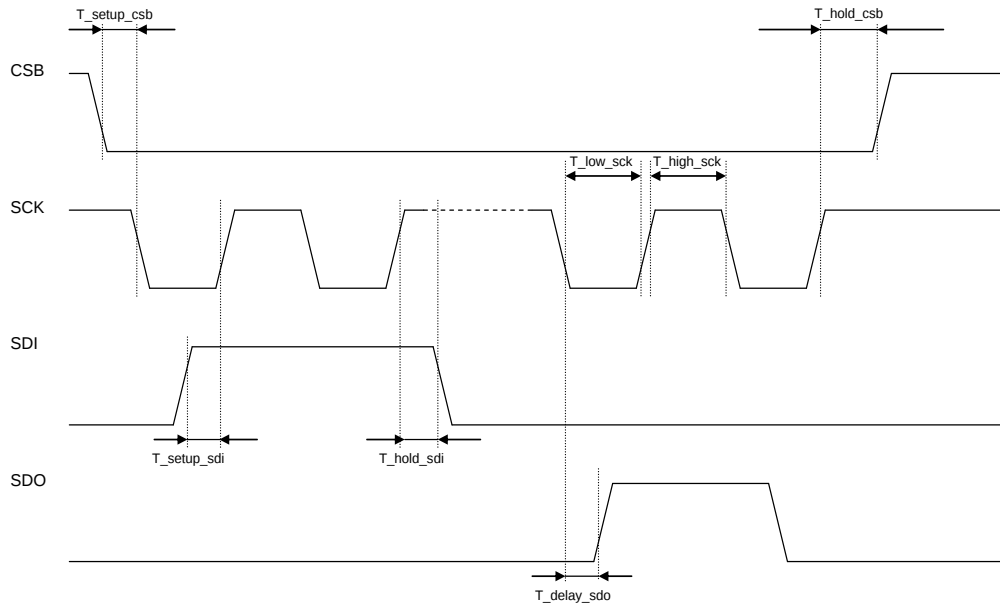


Figure 22: SPI timing diagram

Table 48: SPI timings

| Parameter                 | Symbol                 | Condition                              | Min | Typ | Max | Units |
|---------------------------|------------------------|----------------------------------------|-----|-----|-----|-------|
| SPI clock input frequency | F <sub>spi</sub>       |                                        | 0   |     | 10  | MHz   |
| SCK low pulse             | T <sub>low_sck</sub>   |                                        | 20  |     |     | ns    |
| SCK high pulse            | T <sub>high_sck</sub>  |                                        | 20  |     |     | ns    |
| SDI setup time            | T <sub>setup_sdi</sub> |                                        | 20  |     |     | ns    |
| SDI hold time             | T <sub>hold_sdi</sub>  |                                        | 20  |     |     | ns    |
| SDO output delay          | T <sub>delay_sdo</sub> | 25pF load, V <sub>DDIO</sub> =1.6V min |     |     | 30  | ns    |
| SDO output delay          | T <sub>delay_sdo</sub> | 25pF load, V <sub>DDIO</sub> =1.2V min |     |     | 40  | ns    |
| CSB setup time            | T <sub>setup_csb</sub> |                                        | 20  |     |     | ns    |
| CSB hold time             | T <sub>hold_csb</sub>  |                                        | 20  |     |     | ns    |

## 6. Pin-out and connection diagram

### 6.1. Pin-out

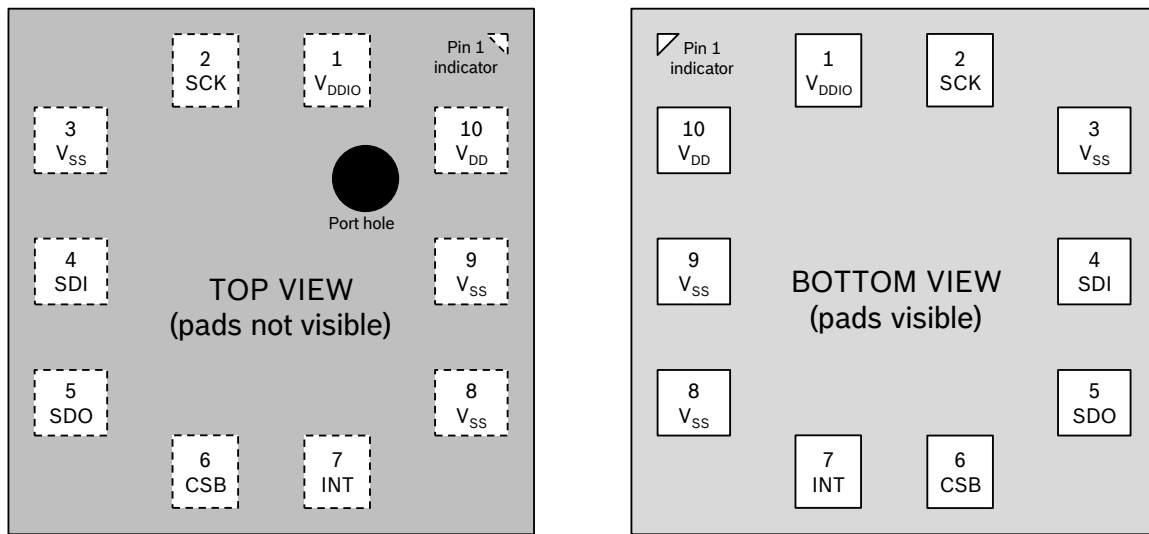


Figure 23: Pin-out top and bottom view

Table 49: Pin description

| Pin | Name  | I/O Type | Description              | Connect to                         |         |
|-----|-------|----------|--------------------------|------------------------------------|---------|
|     |       |          |                          | SPI 4W                             | SPI 3W  |
| 1   | VDDIO | Supply   | Digital interface supply | V <sub>DDIO</sub>                  |         |
| 2   | SCK   | In       | Serial clock input       | SCK                                | SCK     |
| 3   | VSS   | Supply   | Ground                   | GND                                |         |
| 4   | SDI   | In/Out   | Serial data input        | SDI                                | SDI/SDO |
| 5   | SDO   | In/Out   | Serial data output       | SDO                                | DNC     |
| 6   | CSB   | In       | Chip select              | CSB                                | CSB     |
| 7   | INT   | Out      | INT output               | host INT input or DNC <sup>7</sup> |         |
| 8   | VSS   | Supply   | Ground                   | GND                                |         |
| 9   | VSS   | Supply   | Ground                   | GND                                |         |
| 10  | VDD   | Supply   | Analog supply            | V <sub>DD</sub>                    |         |

<sup>7</sup> GND connection in legacy BMP282 systems is allowed, as long as the IRQ pin is not activated

## 6.2. Connection diagram 3-wire SPI

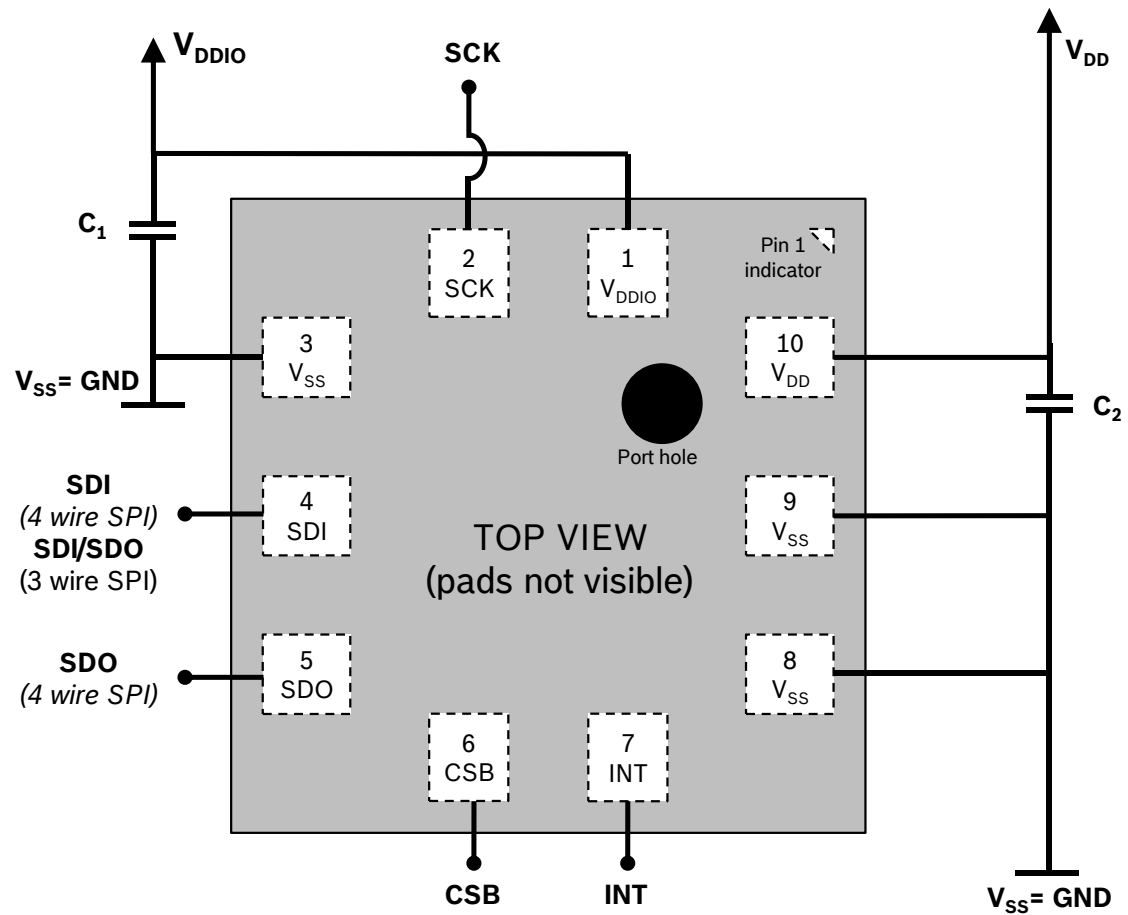


Figure 24: 3 and 4-wire SPI connection diagram (Pin1 marking indicated).

Note: the recommended value for  $C_1$ ,  $C_2$  is 100 nF.

### 6.3. Connection diagram I<sup>2</sup>C

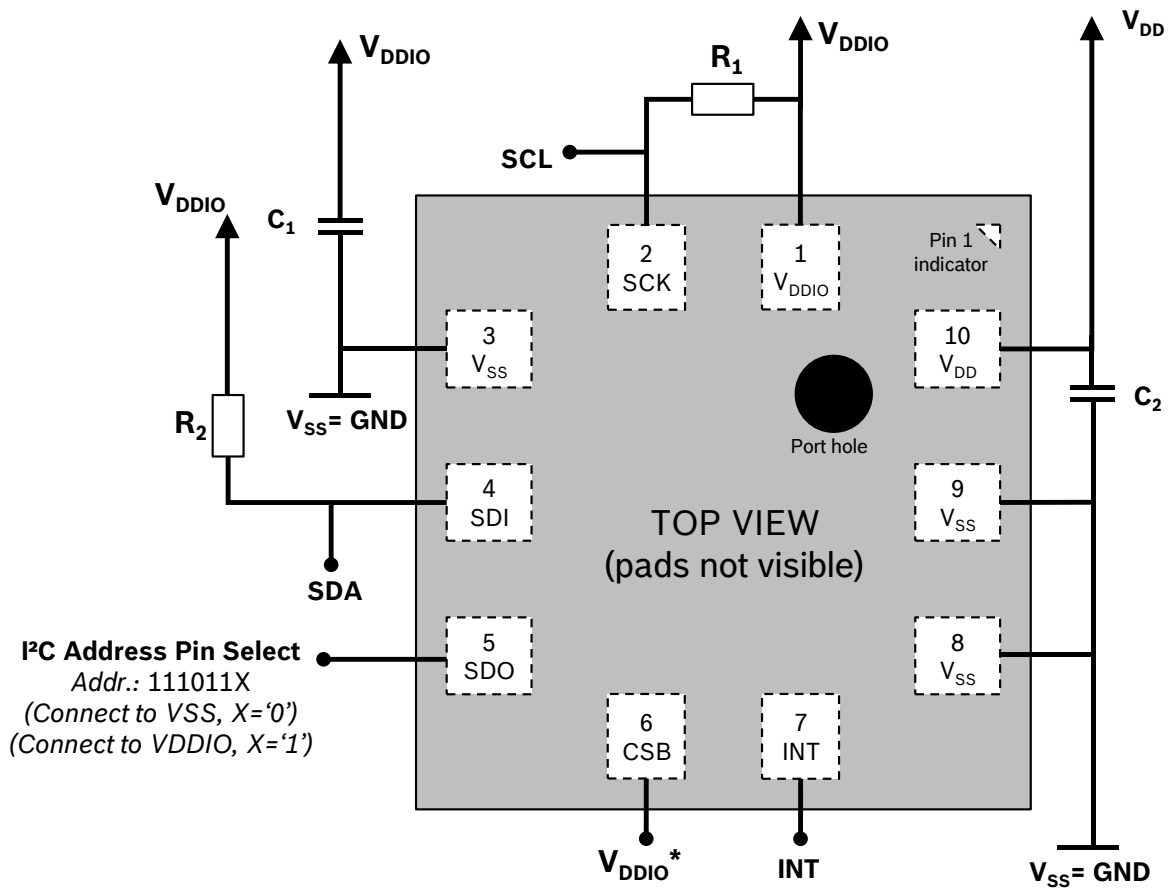


Figure 25: I<sup>2</sup>C connection diagram (Pin1 marking indicated)

#### Notes:

- the recommended value for C<sub>1</sub>, C<sub>2</sub> is 100 nF and for R<sub>1</sub>, R<sub>2</sub> is 4.7 kΩ.
- \*: It is recommended to connect the BMP388 CSB pin to programmable pin which drives V<sub>DDIO</sub> at POR of device (see Chapter 5.1)

## 7. Package, reel and environment

### 7.1. Outline dimensions

The sensor housing is an 10-pin metal-lid LGA 2.0×2.0×0.75 mm<sup>3</sup> package (typ.). Its dimensions are depicted in Figure 26.

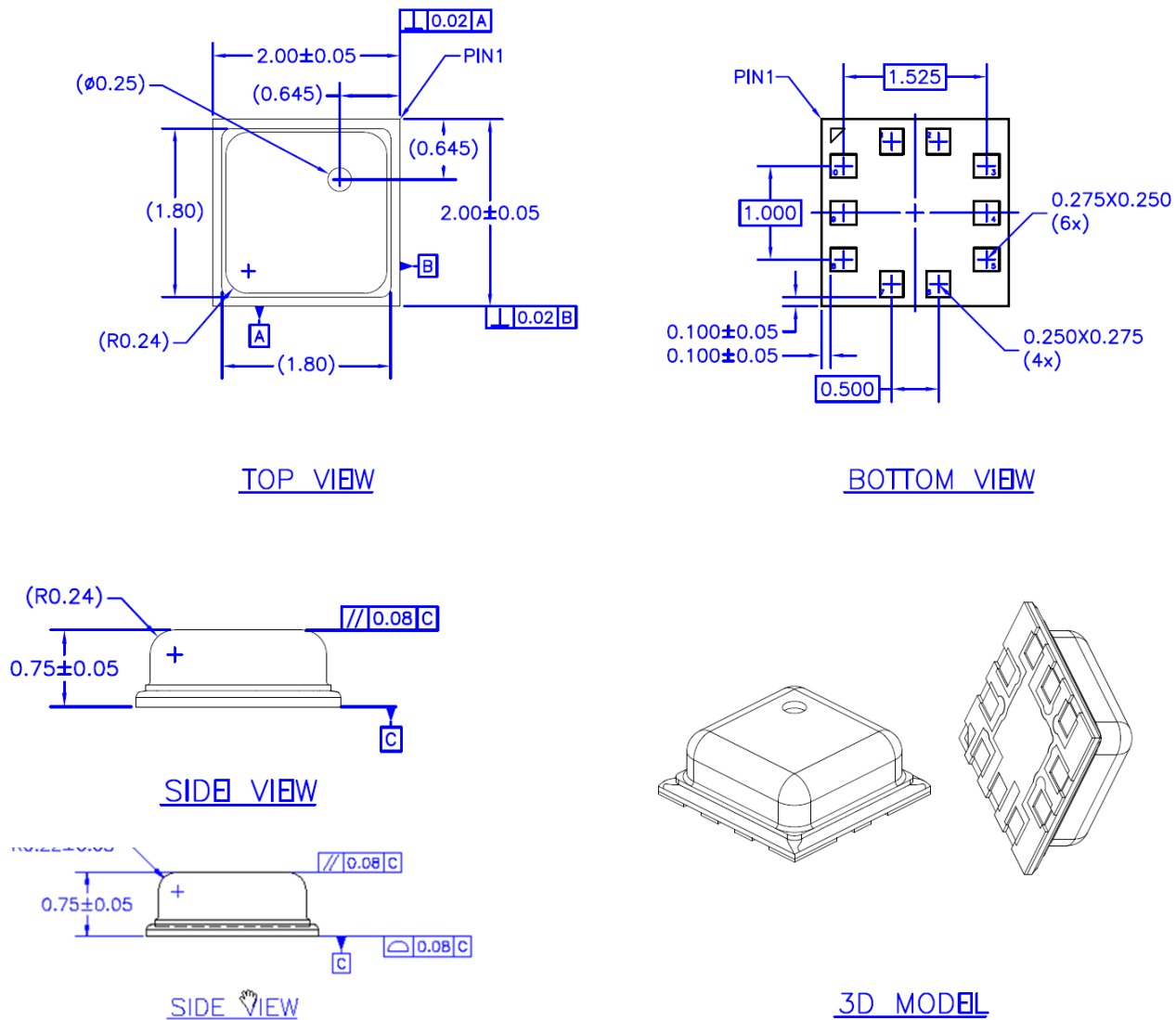


Figure 26: Package outline dimensions BMP388 for top, bottom, side and 3D view

Note: General tolerances are  $\pm 50 \mu\text{m}$  (linear) and  $\pm 1^\circ$   $\mu\text{m}$  (angular)

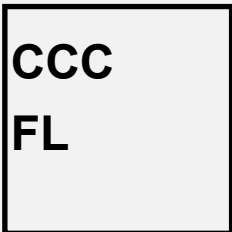
### 7.2. Landing pattern

Bosch Sensortec suggests the BMP388 outline Dimensions (see 7.1- bottom view) as landing pattern.

## 7.3. Marking

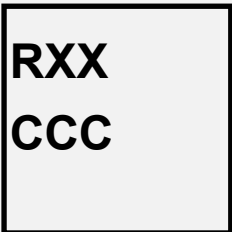
### 7.3.1. Mass production samples

Table 50: Marking of mass production samples

| Labeling                                                                          | Name               | Symbol | Remark                                                                                                             |
|-----------------------------------------------------------------------------------|--------------------|--------|--------------------------------------------------------------------------------------------------------------------|
|  | Lot Counter ID     | CCC    | 3 alphanumeric digits, variable to generate mass production trace code                                             |
|                                                                                   | Product number     | F      | alphanumeric digit to identify product type, "F" is associated with the product BMP388 (part number 0 273 300 511) |
|                                                                                   | Sub-con ID         | L      | 1 alphanumeric digit, variable to identify sub-con                                                                 |
|                                                                                   | Orientation marker | ●      | Vent hole                                                                                                          |

### 7.3.2. Engineering samples

Table 51: Marking of engineering samples

| Labeling                                                                            | Name               | Symbol | Remark                                                                             |
|-------------------------------------------------------------------------------------|--------------------|--------|------------------------------------------------------------------------------------|
|  | Eng. Sample ID     | R      | 1 alphanumeric digit, fixed identification of sample status<br>R="A" or "C" or "F" |
|                                                                                     | Sample ID          | XX     | 2 alphanumeric digit, variable identification of sample lot number                 |
|                                                                                     | Counter ID         | CCC    | 2 or 3 alphanumeric digits, variable to generate trace-code                        |
|                                                                                     | Orientation marker | ●      | Vent hole                                                                          |



## 7.5. Tape and reel specification

### 7.5.1. Dimensions

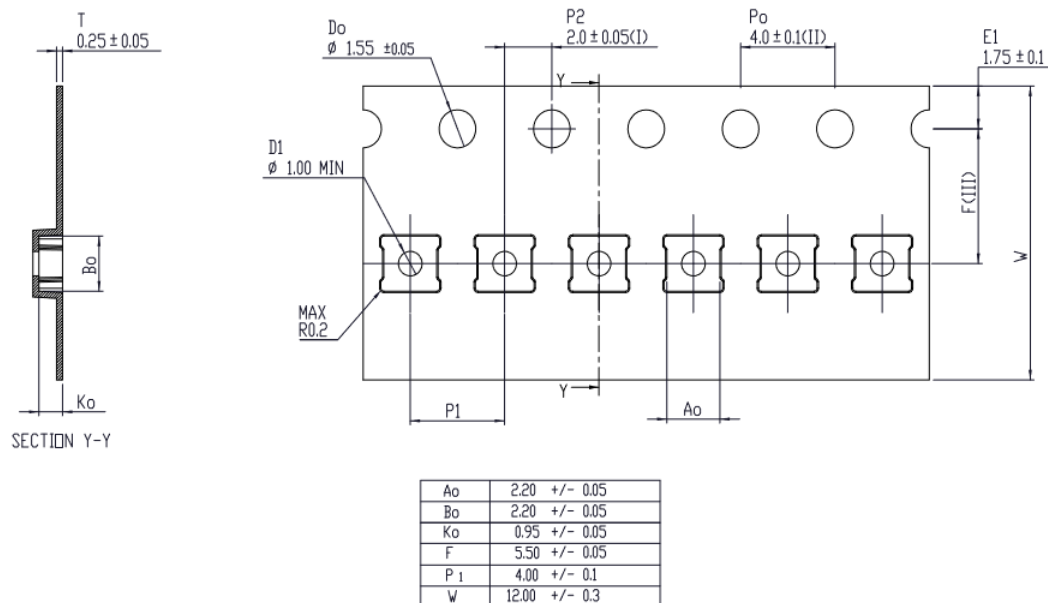


Figure 28: Tape and Reel dimensions

Quantity per reel: 10 kpcs.

### 7.5.2. Orientation within the reel

The orientation of the sensor placement inside the tape on reel can be found below.

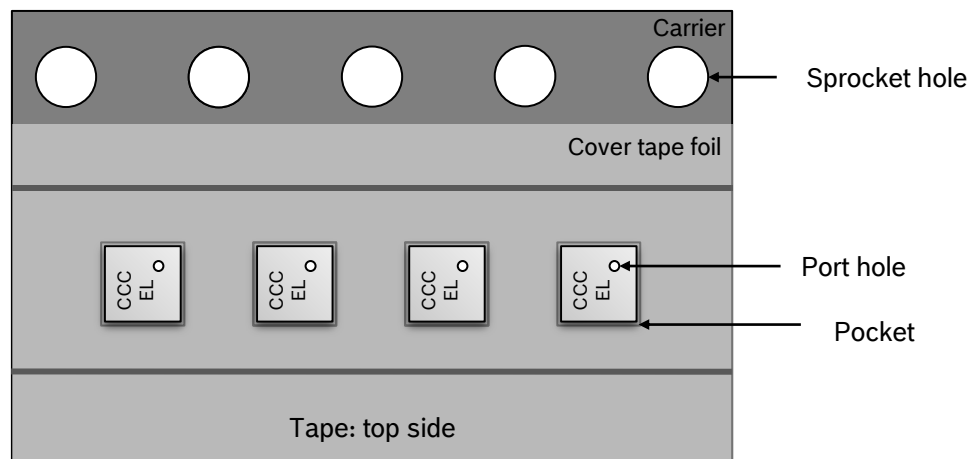


Figure 29: Orientation within tape

## 7.6. Mounting and assembly recommendations

In addition to "Handling, soldering & mounting instructions BMP38x", the following recommendations should be taken into consideration when mounting a pressure sensor on a printed-circuit board (PCB):

- The clearance above the metal lid shall be 0.1mm at minimum.
- For the device housing appropriate venting needs to be provided in case the ambient pressure shall be measured.
- Liquids shall not come into direct contact with the device.
- During operation the sensor chip is sensitive to light, which can influence the accuracy of the measurement (photo-current of silicon). The position of the vent hole minimizes the light exposure of the sensor chip. Nevertheless, BST recommends to avoid the exposure of BMP388 to strong light sources.
- Soldering must not be done using vapor phase processes since the sensor might be damaged.

## 7.7. Environmental safety

### 7.7.1. RoHS

The BMP388 sensor meets the requirements of the EC restriction of hazardous substances (RoHS) directive, see also: Directive 2002/95/EC of the European Parliament and of the Council of 8 September 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

### 7.7.2. Halogen content

The BMP388 is halogen-free. For more details on the analysis results please contact your Bosch Sensortec representative.

### 7.7.3. Internal package structure

Within the scope of Bosch Sensortec's ambition to improve its products and secure the mass product supply, Bosch Sensortec qualifies additional sources (e.g. 2<sup>nd</sup> source) for the LGA package of the BMP388.

While Bosch Sensortec took care that all of the technical packages parameters are described above are 100% identical for all sources, there can be differences in the chemical content and the internal structural between the different package sources.

However, as secured by the extensive product qualification process of Bosch Sensortec, this has no impact to the usage or to the quality of the BMP388 product.

## 8. Legal disclaimer

### 8.1. Engineering samples

Engineering Samples are marked with an asterisk (\*) or € or €. Samples may vary from the valid technical specifications of the product series contained in this data sheet. They are therefore not intended or fit for resale to third parties or for use in end products. Their sole purpose is internal client testing. The testing of an engineering sample may in no way replace the testing of a product series. Bosch Sensortec assumes no liability for the use of engineering samples. The Purchaser shall indemnify Bosch Sensortec from all claims arising from the use of engineering samples.

### 8.2. Product use

Bosch Sensortec products are developed for the consumer goods industry. They may only be used within the parameters of this product data sheet. They are not fit for use in life-sustaining or safety-critical systems. Safety-critical systems are those for which a malfunction is expected to lead to bodily harm or significant property damage. In addition, they are not fit for use in products which interact with motor vehicle systems.

The resale and/or use of products are at the purchaser's own risk and his own responsibility. The examination of fitness for the intended use is the sole responsibility of the Purchaser.

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The purchaser must monitor the market for the purchased products, particularly with regard to product safety, and inform Bosch Sensortec without delay of all safety relevant incidents.

### 8.3. Application examples and hints

With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Bosch Sensortec hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights or copyrights of any third party. The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. They are provided for illustrative purposes only and no evaluation regarding infringement of intellectual property rights or copyrights or regarding functionality, performance or error has been made.

## 9. Appendix: Computation formulae reference implementation

The code below gives a provides a C implementation of the compensation algorithms discussed in Sec. 3.10.

The struct BMP388\_calib\_data is a structure, that contains the calibration coefficients. And the t\_lin variable that carries a temperature value over to the pressure compensation.

### 9.1. Calibration coefficient

The calibration coefficients are stored as described in Table 22. The compensation formula is implemented in floating point. Therefore the coefficient have to be converted into floating point numbers by the following formulas.

$$PAR\_T1 = \frac{NVM\_PAR\_T1}{2^{-8}} \quad PAR\_T2 = \frac{NVM\_PAR\_T2}{2^{30}} \quad PAR\_T3 = \frac{NVM\_PAR\_T3}{2^{48}}$$

$$PAR\_P1 = \frac{NVM\_PAR\_P1 - 2^{14}}{2^{20}} \quad PAR\_P2 = \frac{NVM\_PAR\_P2 - 2^{14}}{2^{29}} \quad PAR\_P3 = \frac{NVM\_PAR\_P3}{2^{32}}$$

$$PAR\_P4 = \frac{NVM\_PAR\_P4}{2^{37}} \quad PAR\_P5 = \frac{NVM\_PAR\_P5}{2^{-3}} \quad PAR\_P6 = \frac{NVM\_PAR\_P6}{2^6}$$

$$PAR\_P7 = \frac{NVM\_PAR\_P7}{2^8} \quad PAR\_P8 = \frac{NVM\_PAR\_P8}{2^{15}} \quad PAR\_P9 = \frac{NVM\_PAR\_P9}{2^{48}}$$

$$PAR\_P10 = \frac{NVM\_PAR\_P10}{2^{48}} \quad PAR\_P11 = \frac{NVM\_PAR\_P11}{2^{65}}$$

### 9.2. Temperature compensation

```
static float BMP388_compensate_temperature(uint32_t uncomp_temp, struct BMP388_calib_data *calib_data)
{
    float partial_data1;
    float partial_data2;

    partial_data1 = (float)(uncomp_temp - calib_data->par_t1);
    partial_data2 = (float)(partial_data1 * calib_data->par_t2);
    /* Update the compensated temperature in calib structure since this is
    * needed for pressure calculation */
    calib_data->t_lin = partial_data2 + (partial_data1 * partial_data1) * calib_data->par_t3;

    /* Returns compensated temperature */
    return calib_data->t_lin;
}
```

### 9.3. Pressure compensation

```
static float BMP388_compensate_pressure(uint32_t uncomp_press, struct BMP388_calib_data *calib_data)
{
    /* Variable to store the compensated pressure */
    float comp_press;
    /* Temporary variables used for compensation */
    float partial_data1;
    float partial_data2;
    float partial_data3;
    float partial_data4;
    float partial_out1;
    float partial_out2;
    /* Calibration data */

    partial_data1 = calib_data->par_p6 * calib_data->t_lin;
    partial_data2 = calib_data->par_p7 * (calib_data->t_lin * calib_data->t_lin);
    partial_data3 = calib_data->par_p8 * (calib_data->t_lin * calib_data->t_lin * calib_data->t_lin);
    partial_out1 = calib_data->par_p5 + partial_data1 + partial_data2 + partial_data3;

    partial_data1 = calib_data->par_p2 * calib_data->t_lin;
    partial_data2 = calib_data->par_p3 * (calib_data->t_lin * calib_data->t_lin);
    partial_data3 = calib_data->par_p4 * (calib_data->t_lin * calib_data->t_lin * calib_data->t_lin);
    partial_out2 = (float)uncomp_press *
        (calib_data->par_p1 + partial_data1 + partial_data2 + partial_data3);

    partial_data1 = (float)uncomp_press * (float)uncomp_press;
    partial_data2 = calib_data->par_p9 + calib_data->par_p10 * calib_data->t_lin;
    partial_data3 = partial_data1 * partial_data2;
    partial_data4 = partial_data3 + ((float)uncomp_press * (float)uncomp_press * (float)uncomp_press) * calib_data->par_p11;
    comp_press = partial_out1 + partial_out2 + partial_data4;

    return comp_press;
}
```

## 10. Document history and modification

| Rev. No | Section | Description of modification/changes             | Date       |
|---------|---------|-------------------------------------------------|------------|
| 0.1     |         | Document Creation                               | 21.11.2016 |
| 0.2     | 7.4.2   | Added 7.4.2 Orientation within the reel         | 13.03.2017 |
|         | 1       | Added min/max data for restricted datasheet     |            |
| 0.3     | 7.1     | Added warpage information                       | 14.07.2017 |
| 0.4     | 1       | Added min/max values and noise figures          | 18.10.2017 |
|         | 3.4.4   | Updated noise values                            |            |
|         | 3.5     | Updated filter settings for different use cases |            |
| 1.0     |         | Final official version                          | 15.01.2018 |
| 1.1     | 7.3.2   | Change of laser marking definition              | 14.03.2018 |
| 1.1     | 1       | Added missing sigma                             | 25.04.2018 |
|         | 3       | Changed coefficient from 128 to 127             |            |
|         | 3.11.1  | Change 0x3B register content to NVM_PAR_P4      |            |
|         | 4.3.11  | Greyed out unused bits                          |            |
|         | 3.4     | Updated reference links                         |            |
|         | 3.4.2   | Updated header number                           |            |
|         | 4.3.11  | Changed watermark name                          |            |
|         | 7.3.2   | Updated marking of engineering samples          |            |



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